

# Appendix D

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## Control system hardware

This Appendix lists the specifications of the industrial accelerometer and air gap sensor, and the schematic diagrams for all of the control system hardware. The various system components are listed below:

D.1	Accelerometer	180
D.2	Air gap sensor	182
D.3	Equipment chassis configurations	183
	D.3.1 Single electromagnet suspension system	183
	D.3.2 Vehicle suspension system	183
D.4	Analogue-to-digital converter (8 channel) card	184
	D.4.1 ADC card power supplies	185
	D.4.2 ADC processor & link interfaces	186
	D.4.3 ADC anti-alias filters, multiplexer & converter	187
	D.4.4 ADC card component parts list	188
D.5	Digital-to-analogue converter (4 channel) card	189
	D.5.1 DAC card power supplies	190
	D.5.2 DAC processor & link interfaces (optical & electrical)	191
	D.5.3 DAC converters & watchdog timer	192
	D.5.4 DAC card component parts list	193
D.6	Electromagnet current controller module	194
	D.6.1 EMCA controller logic	195

- D.6.2 EMCA power switching bridge . . . . . 196
- D.6.3 EMCA card component parts list . . . . . 197
  
- D.7 Chassis power supply module . . . . . 198
  - D.7.1 PSU supply conditioning . . . . . 199
  - D.7.2 PSU card component parts list . . . . . 200
  
- D.8 Chassis optical input interface card . . . . . 201
  - D.8.1 Chassis input interface power supply . . . . . 202
  - D.8.2 Chassis input interface control signals . . . . . 203
  - D.8.3 Chassis input interface data signals . . . . . 204
  - D.8.4 Chassis input interface card component parts list . . . . . 205
  
- D.9 Chassis optical output interface card . . . . . 206
  - D.9.1 Chassis output interface power supply . . . . . 207
  - D.9.2 Chassis output interface control signals . . . . . 208
  - D.9.3 Chassis output interface data signals . . . . . 209
  - D.9.4 Chassis output interface card component parts list . . . . . 210
  
- D.10 Sensor analogue preprocessor (4 channel) card . . . . . 211
  - D.10.1 SAP card power supplies . . . . . 212
  - D.10.2 SAP Hall-effect air gap sensor controllers . . . . . 213
  - D.10.3 SAP sensor filters and amplifiers . . . . . 214
  - D.10.4 SAP card component parts list . . . . . 215
  
- D.11 Transputer motherboard (4 tram) card . . . . . 216
  - D.11.1 TMB card power supply . . . . . 217
  - D.11.2 TMB TRAM connectivity . . . . . 218
  - D.11.3 TMB card component parts list . . . . . 219

## D.1 Accelerometer

The Model 3110 is a general purpose, solid-state, piezo-resistive accelerometer with built-in amplification and temperature compensation. The module consists of a silicon micro-machined accelerometer.

### ICSensors, accelerometer, model 3110-002, specifications.

(Supply voltage = 10 Vdc, Ambient temperature = 25 °C)

PARAMETERS	Min	Typ	Max	Units	Notes
Range		±2		g	
Frequency Response		0-350		Hz	
Mounted Resonant Frequency		600		Hz	
Full Scale Output (- Acc)		0.5		Volts	1
Full Scale Output (+ Acc)		4.5		Volts	1
Full Scale Output Span	3.96	4.00	4.04	Volts	1
Zero Acceleration Output	2.48	2.5	2.52	Volts	1
Damping Factor		0.7			2
Accuracy		0.2	1.0	±%Span	3
Transverse Sensitivity		1.0	3.0	±%Span	
Temperature Coefficient - Span		1.0	2.0	±%Span	4
Temperature Coefficient - Zero		1.0	2.0	±%Span	4
Supply Voltage	8.0	10.0	30.0	Volts	
Supply Current		5.0		mA	
Output Resistance		0.1		Ω	
Output Noise		0.5		mV p-p	
Output Load Resistance	2			kΩ	
Acceleration Limits		20x		Rated	
Operating Temperature	-20		+85	°C	
Storage Temperature	-40		+125	°C	
Weight (Excluding Cable)		23		Grams	

**Notes**

1. The output voltage increases from the Zero Acceleration Output for positive acceleration and decreases for negative acceleration. The sensitivity is then 2V/Range.
2. The 0.7 damping factor represents critical damping. The damping factor is controlled to within  $\pm 10\%$  over the entire operating temperature range. Alternate damping factors are available on a special order basis.
3. Includes repeatability, hysteresis and linearity (best straight line fit).
4. Compensated temperature range: 0 to 50 °C in reference to 25 °C.
5. See Model 3021 for an accelerometer without amplification and compensation.
6. Pin 2 provides an optional 2.5 V reference which may be used, if desired, to provide a stable zero-g reference. Thus, the full scale differential output between Pin 2 and Pin 4 would be  $\pm 2$  Vdc. If a single-ended output signal is preferred (0.5-4.5 Vdc), make no connection to Pin 2.

**ICSensors, Model 3110, Pin connections.**

<b>Pin:</b>	1	2	3	4	5
<b>Function:</b>	Ground	Zero-g ref.	Supply (+)	Output	Test point

## D.2 Air gap sensor

The non-contacting air gap sensor used is a general purpose device, which uses the power loss due to eddy currents in the target to determine the air gap or material properties. For accurate measurement of air gap, the resistivity of the target must remain constant, ie. known material and constant temperature.

### Pepperl+Fuchs, Inductive displacement sensor, model IA8-M1K-I3, specifications.

PARAMETERS	VALUES
Sensing Range	3mm - 8 mm
<b>Nominal Values:</b>	
Damping plate, 1mm St 37	35 mm x 35 mm
Linearity (rel. to FSD)	$\pm 3\%$
Zero Tolerance	$\pm 2\%$
Working Voltage	15 to 30 V dc
Cut-off Frequency (3 dB)	$\approx 190$ Hz
Repeatability Accuracy	$\leq 15$ $\mu\text{m}$
Hysteresis Error	$\leq 30$ $\mu\text{m}$
<b>Electrical Data:</b>	
Output Signal	0 - 20 mA
Load Resistance $R_L$	0..500 $\Omega$
Quiescent Current Consumption	< 8 mA
Ripple Current (measured @ $R_L=100\Omega$ )	$\approx \pm 1.5\%$ FSD
Temperature Drift (target & transducer at same temperature)	$\approx \pm 1$ %/K FSD
Current Consumption max.	$\leq 35$ mA
<b>Mechanical Data:</b>	
Ambient Temperature	-10 to +70 °C
Protection class to DIN 40 050	IP 67
Permissible shock and vibration stresses	b $\leq 30$ g, T $\leq 11$ ms f $\leq 55$ Hz, a $\leq 1$ mm
Type of connection	Wire, $\phi \leq 2.5\text{mm}^2$

The useable sensing range with the MAGLEV track as target is about 3 mm - 10 mm, with distances above 8 mm being outside the rated specification (see full data sheet).

### D.3 Equipment chassis configurations

All equipment chassis are 3U high and 84E wide, ie. for single height, short eurocards (160 x 100 mm). The single electromagnet suspension contains all cards and modules in one chassis, whilst the multi-magnet vehicle uses 2 chassis: one with the DAC and the power controllers, and the other with the ADCs, processors and PSUs.

#### D.3.1 Single electromagnet suspension system

##### Logic & Power Control Chassis

<b>Card:</b>	E M C A	P S U	-	D A C	-	T M B	T M B	I P I F	A D C	S A P	C O N N
<b>Width:</b>	20	10	4	4	4	10	10	4	4	4	10

#### D.3.2 Vehicle suspension system

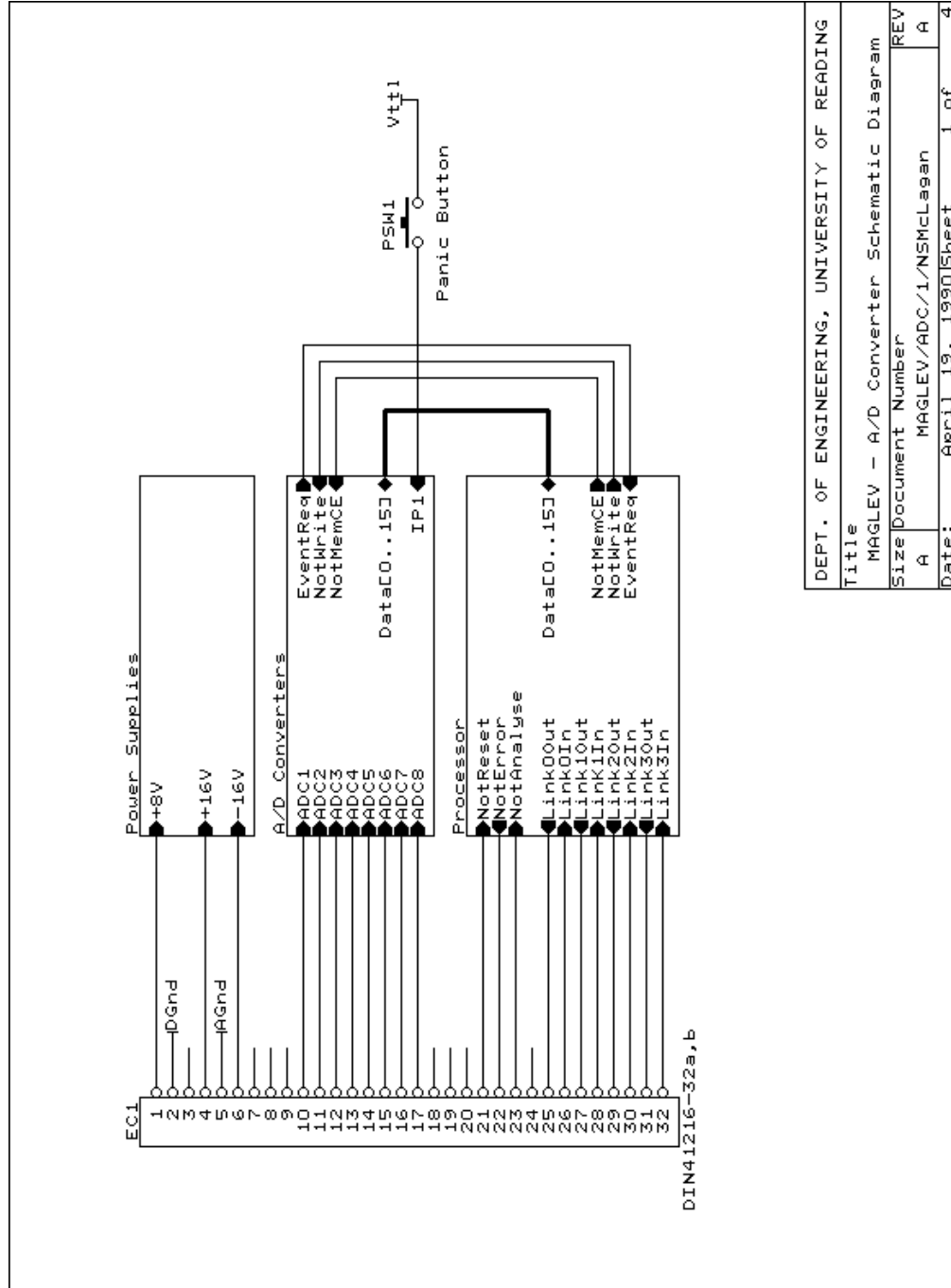
##### Logic Control Chassis

<b>Card:</b>	P S U	P S U	-	O P I F	T M B	T M B	T M B	I P I F	-	A D C	S A P	C O N N
<b>Width:</b>	10	10	4	4	10	10	10	4	4	4	4	10

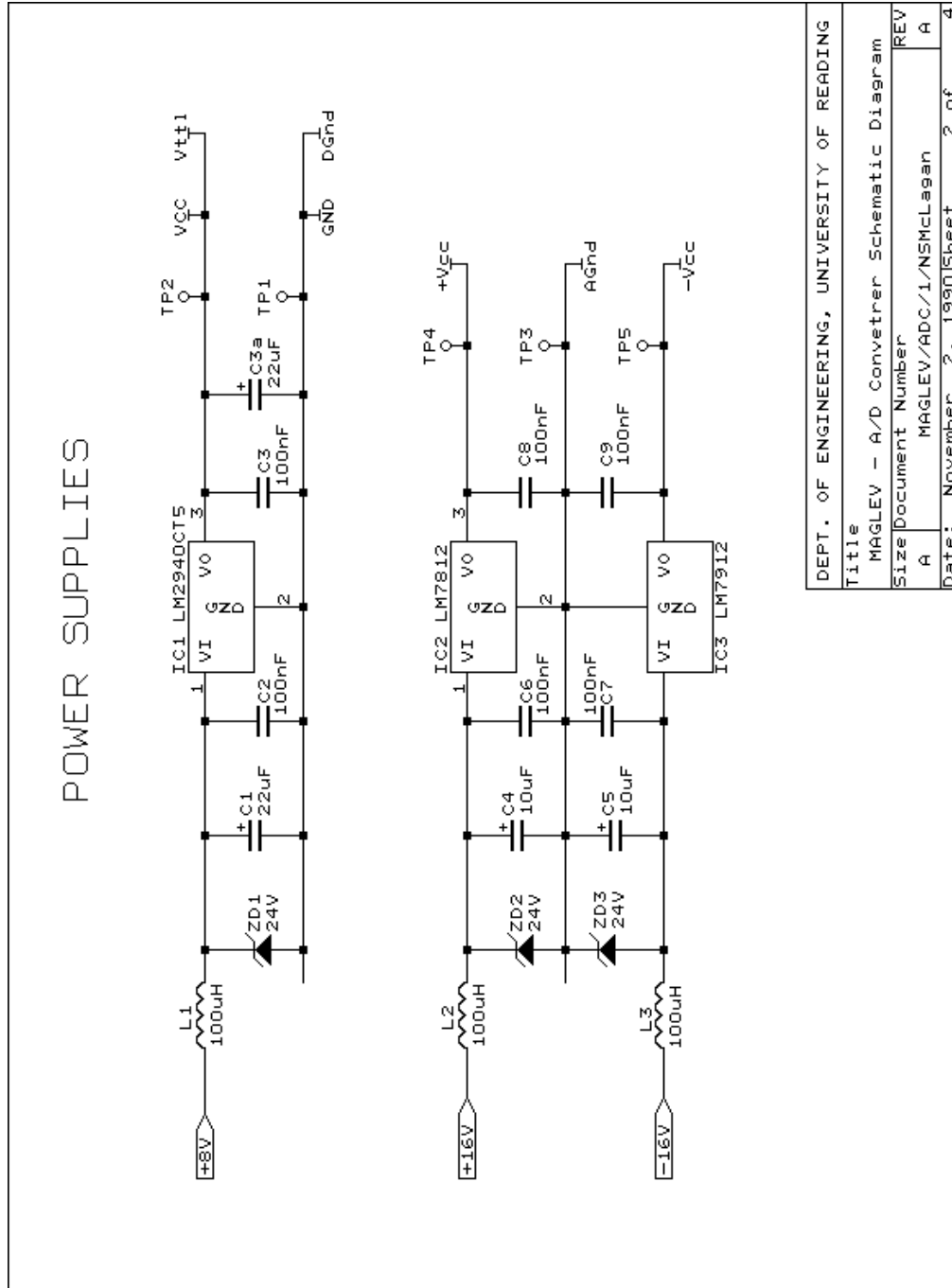
##### Power Control Chassis

<b>Card:</b>	E M C A	E M C A	E M C A	E M C A	D A C
<b>Width:</b>	20	20	20	20	4

D.4 Analogue-to-digital converter (8 channel) card

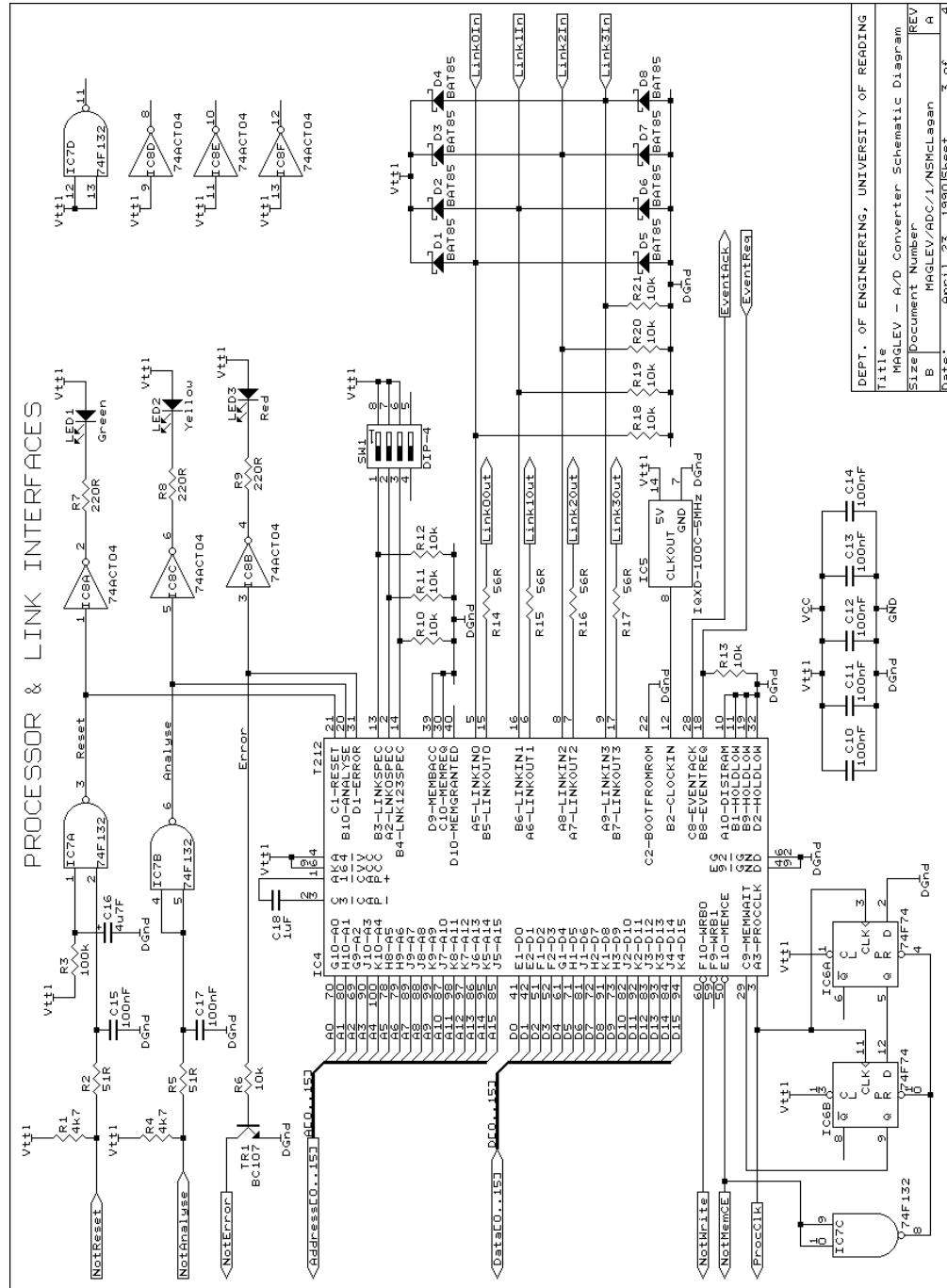


D.4.1 ADC card power supplies



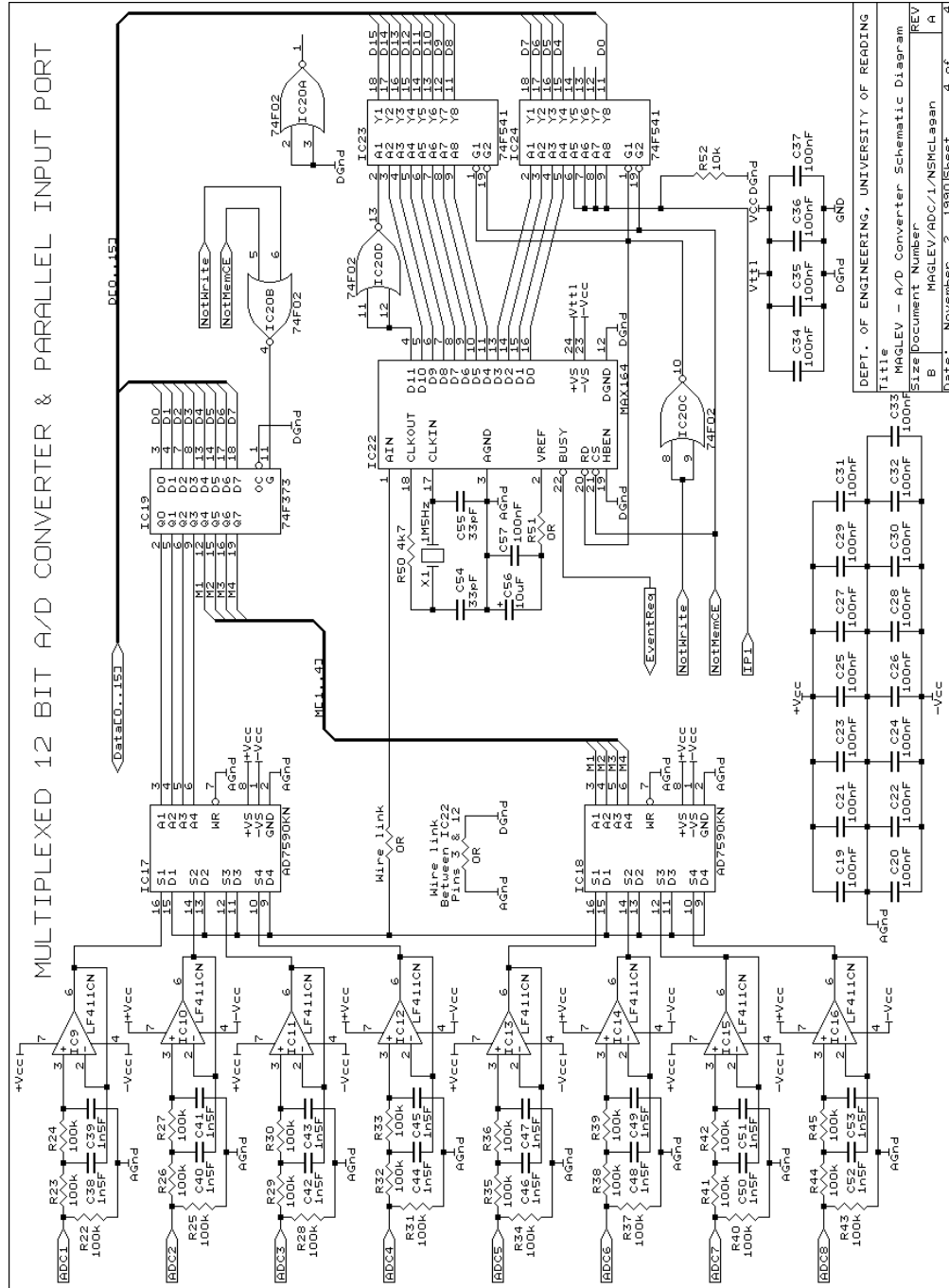


D.4.2 ADC processor & link interfaces



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Title	MAGLEV - A/D Converter Schematic Diagram
Size	Document Number
B	MAGLEV/ADC/1/NSMcLagan
REV	A
Date:	April 23, 1990
Sheet	3 of 4

D.4.3 ADC anti-alias filters, multiplexer & converter



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 Title: MAGLEV - A/D Converter Schematic Diagram  
 Size Document Number: MAGLEV/ADC/1/NSMcLagan  
 Date: November 2, 1990 Sheet 4 of 4

## D.4.4 ADC card component parts list

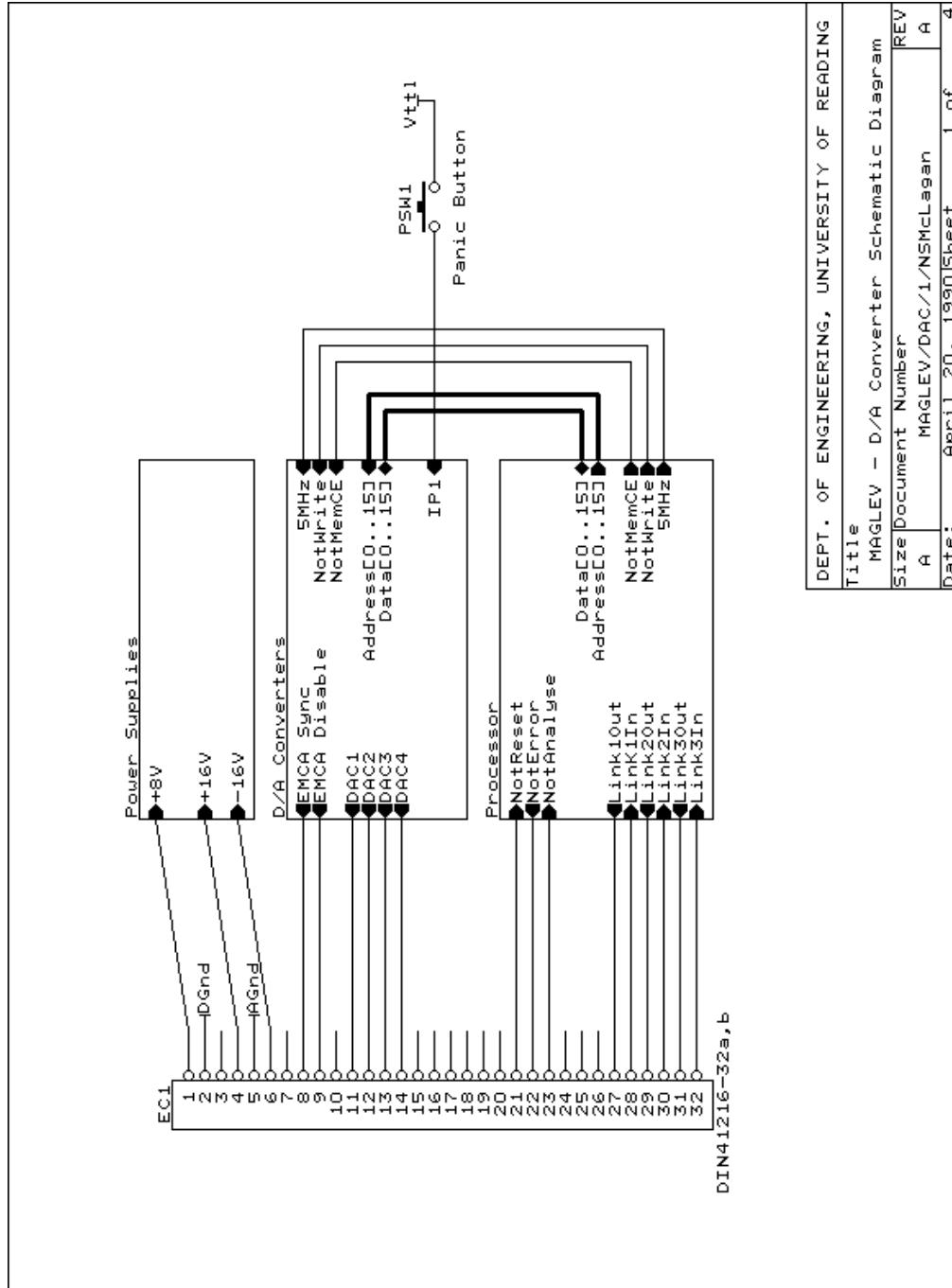
MAGLEV - A/D Converter Schematic Diagram  
MAGLEV/ADC/1/N.S.McLagan

Revised: November 2, 1990  
Revision: A

Bill Of Materials November 2, 1990 16:09:26 Page 1

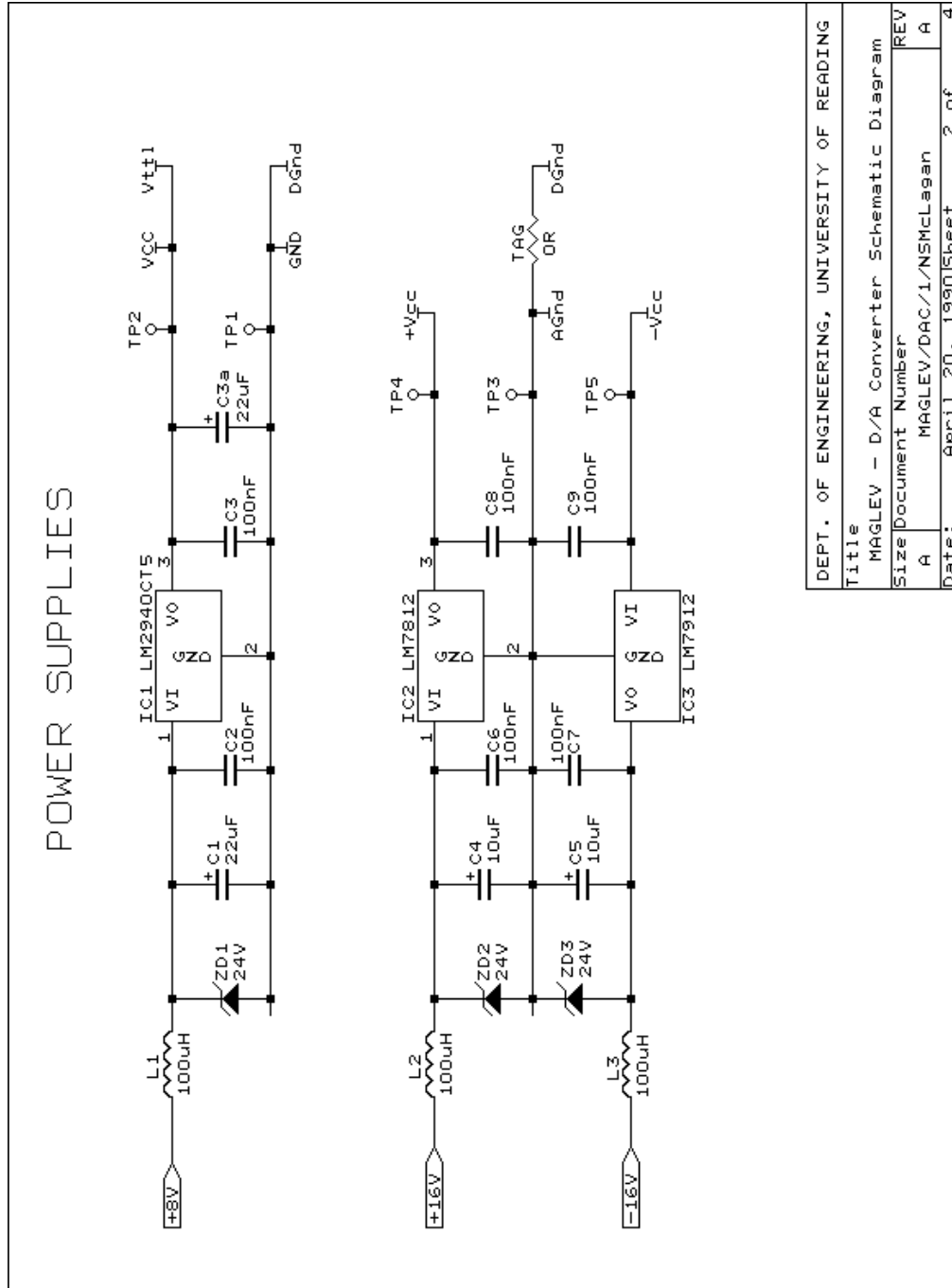
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1	C16	4u7F
1	C18	1uF
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16	C38, C39, C40, C41, C42, C43, C44, C45, C46, C47, C48, C49, C50, C51, C52, C53	1n5F
3	C4, C5, C56	10uF
2	C54, C55	33pF
8	D5, D1, D2, D3, D4, D6, D7, D8	BAT85
1	EC1	DIN41216-32a, b
1	IC1	LM2940CT5
8	IC16, IC9, IC10, IC11, IC12, IC13, IC14, IC15	LF411CN
2	IC17, IC18	AD7590KN
1	IC19	74F373
1	IC2	LM7812
1	IC20	74F02
1	IC22	MAX164BCNG
2	IC23, IC24	74F541
1	IC3	LM7912
1	IC4	T212
1	IC5	IQXD-100C-5MHz
1	IC6	74F74
1	IC7	74F132
1	IC8	74ACT04
3	L2, L1, L3	100uH
1	LED1	Green
1	LED2	Yellow
1	LED3	Red
1	PSW1	Push Switch
3	R1, R4, R50	4k7
4	R15, R14, R16, R17	56R
2	R2, R5	51R
25	R3, R22, R23, R24, R25, R26, R27, R28, R29, R30, R31, R32, R33, R34, R35, R36, R37, R38, R39, R40, R41, R42, R43, R44, R45	100k
1	R51	Wire link
10	R6, R10, R11, R12, R13, R18, R19, R20, R21, R52	10k
3	R7, R8, R9	220R
1	SW1	DIP-4 way SPST
5	TP2, TP1, TP3, TP4, TP5	Test pins
1	TR1	BC107
1	X1	1.5 MHz crystal
3	ZD1, ZD2, ZD3	24V

D.5 Digital-to-analogue converter (4 channel) card

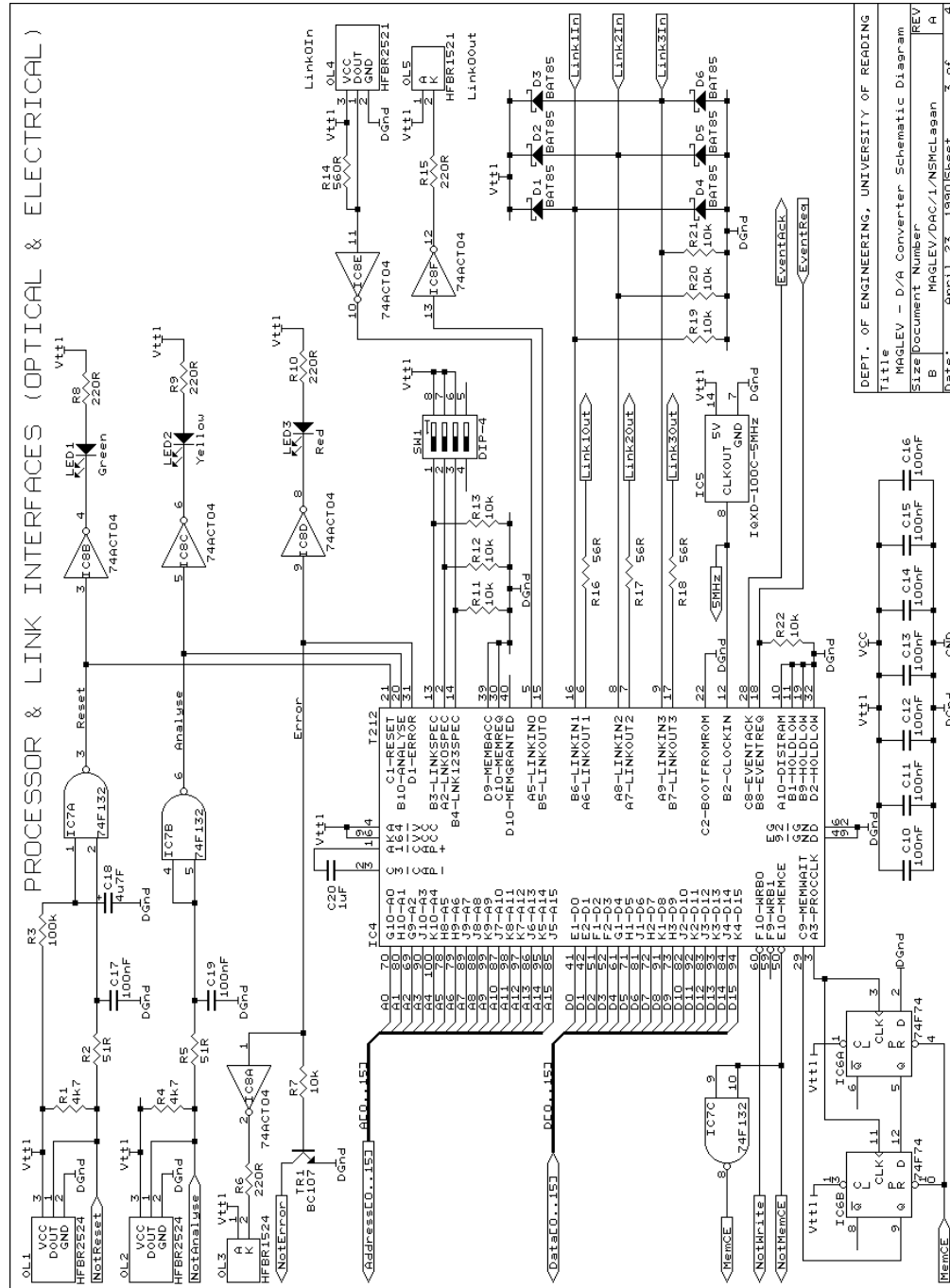


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Size	Document Number
A	MAGLEV/DAC/1/NSMcLagan
REV	A
Date:	April 20, 1990
Sheet	1 of 4

D.5.1 DAC card power supplies



D.5.2 DAC processor & link interfaces (optical & electrical)



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Title	MAGLEV - D/A Converter Schematic Diagram	REV	A
Size Document Number	MAGLEV/DAC/1/NSMcLagan	REV	B
Date:	April 23, 1990	Sheet	3 of 4



## D.5.4 DAC card component parts list

MAGLEV - D/A Converter Schematic Diagram  
MAGLEV/DAC/1/N.S.McLagan

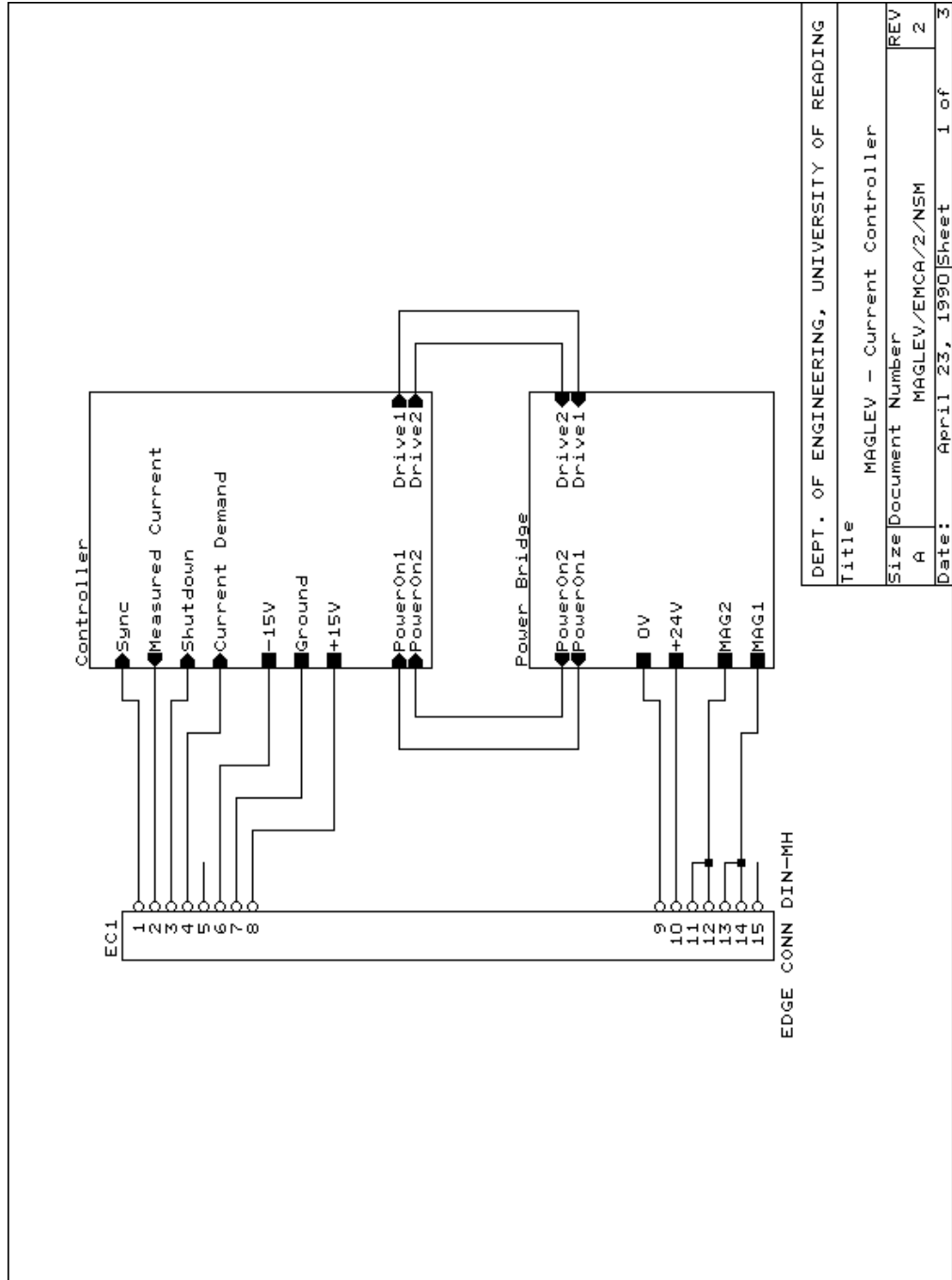
Revised: January 24, 1990  
Revision: A

Bill Of Materials January 25, 1990 16:09:15 Page 1

<u>Quantity</u>	<u>Reference</u>	<u>Part</u>
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1	C18	4u7F
27	C2, C3, C6, C7, C8, C9, C10, C11, C12, C13, C14, C15, C16, C17, C19, C21, C22, C23, C24, C25, C26, C27, C28, C29, C30, C31, C32	100nF
1	C20	1uF
1	C33	470pF
1	C34	220nF
4	C35, C36, C37, C38	22pF
2	C4, C5	10uF
6	D6, D2, D3, D4, D7, D8	BAT85
1	EC1	DIN41216-32a, b
1	IC1	LM2940CT5
1	IC10	74HCT123
4	IC11, IC12, IC13, IC14	AD767
1	IC15	74F541
1	IC16	74ACT4024
4	IC17, IC18, IC19, IC20	LF411CN
1	IC2	LM7812
1	IC3	LM7912
1	IC4	T212
1	IC5	IQXD-100C-5MHz crystal
1	IC6	74F74
1	IC7	74F132
1	IC8	74ACT04
1	IC9	74F138
3	L2, L1, L3	100uH
1	LED1	Green
1	LED2	Yellow
1	LED3	Red
2	OL1, OL2	HFBR2524
1	OL3	HFBR1524
1	OL4	HFBR2521
1	OL5	HFBR1521
1	PSW1	Push switch
4	R1, R4, R24, R27	4k7
2	R15, R6	100R
3	R16, R17, R18	56R
2	R2, R5	51R
1	R23	2k
4	R28, R29, R30, R31	50R
2	R3, R26	100k
1	R14	560R
9	R7, R11, R12, R13, R19, R20, R21, R22, R25	10k
3	R8, R9, R10	220R
1	SW1	DIP-4 way SPST
1	TAG	Earth tag
5	TP2, TP1, TP3, TP4, TP5	Test pins
1	TR1	BC107
3	ZD1, ZD2, ZD3	24V

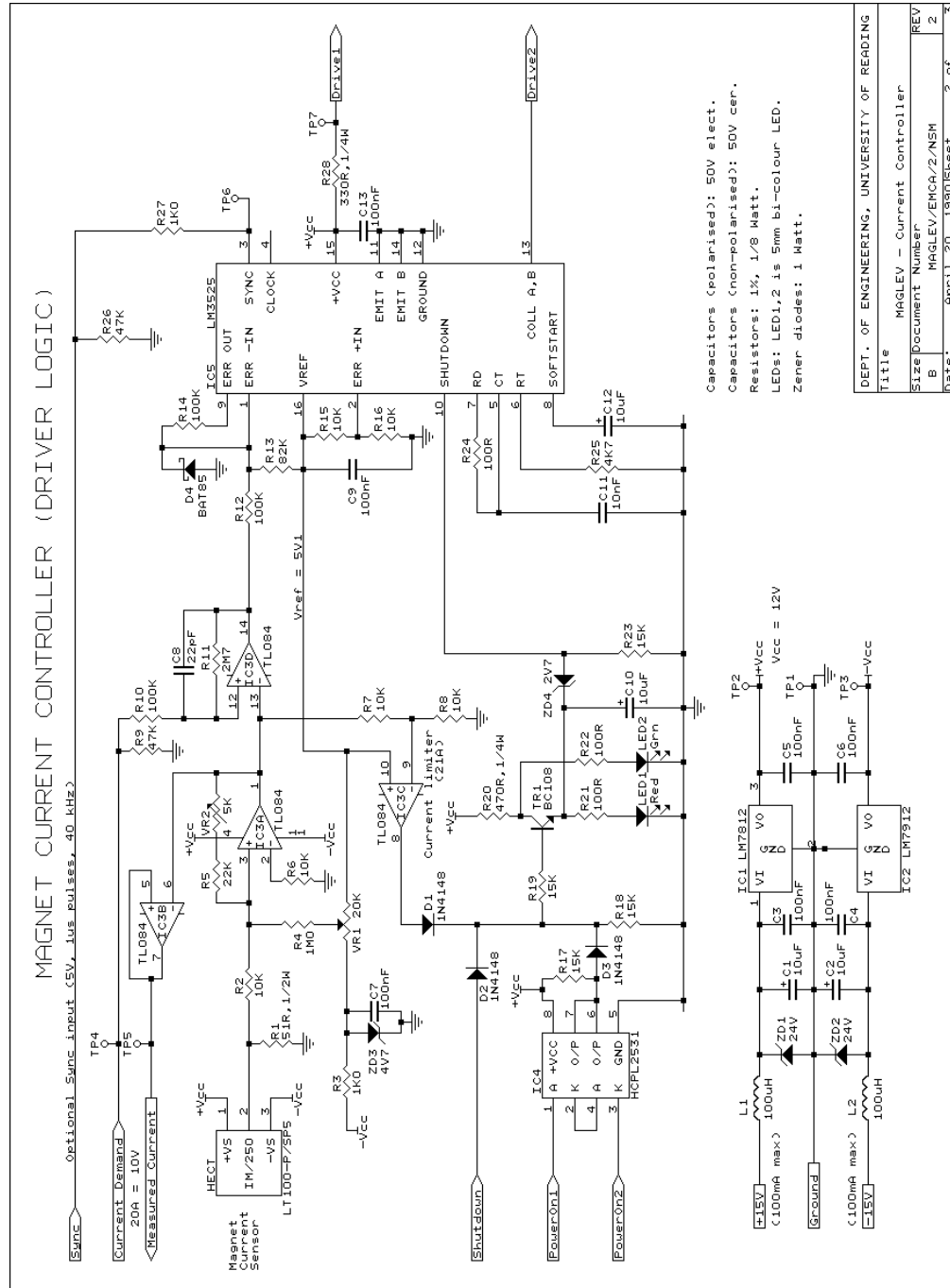


D.6 Electromagnet current controller module

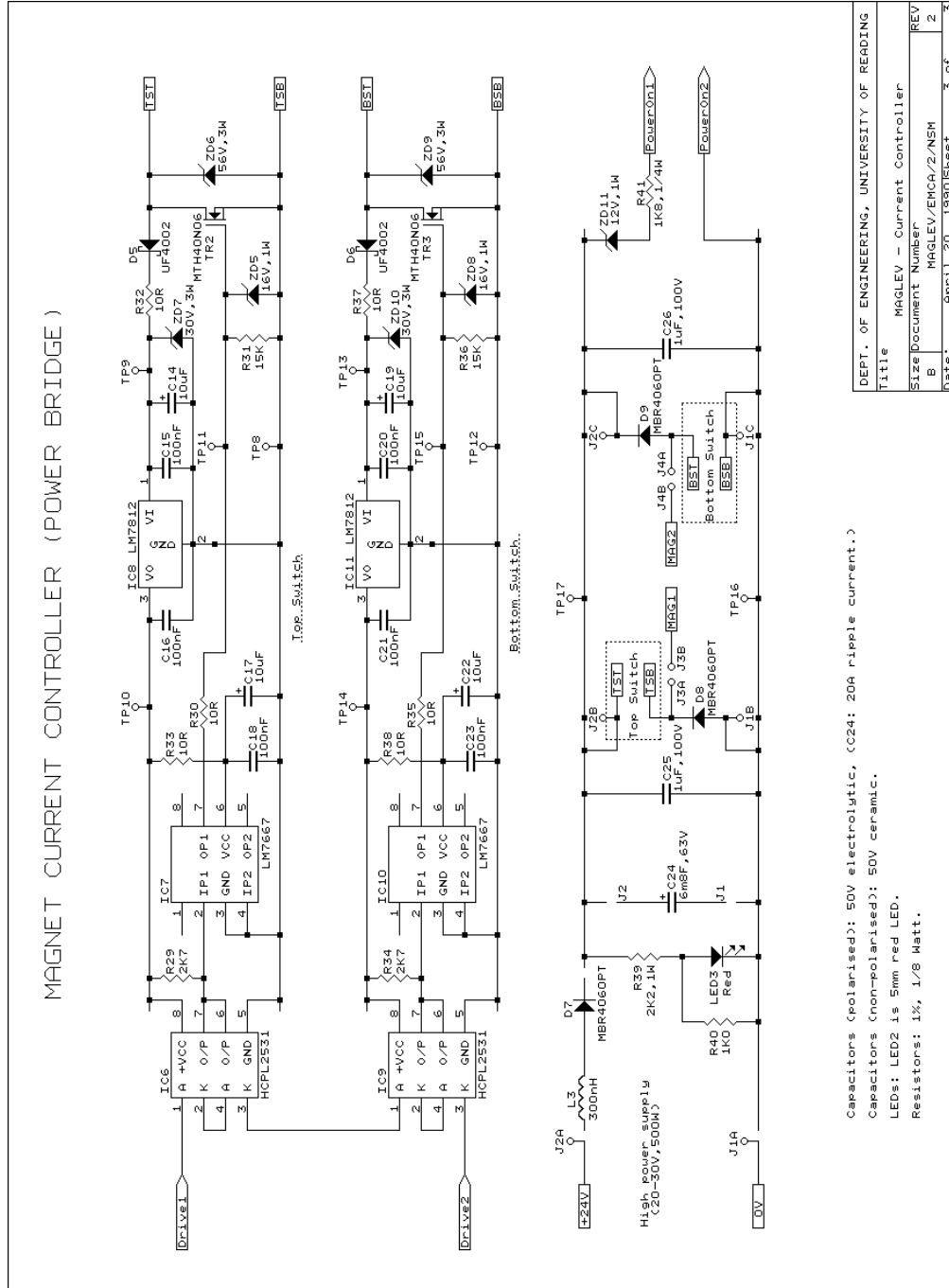


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Title	MAGLEV - Current Controller
Size	Document Number
A	MAGLEV/EMCA/2/NSM
REV	2
Date:	April 23, 1990
Sheet	1 of 3

D.6.1 EMCA controller logic



D.6.2 EMCA power switching bridge



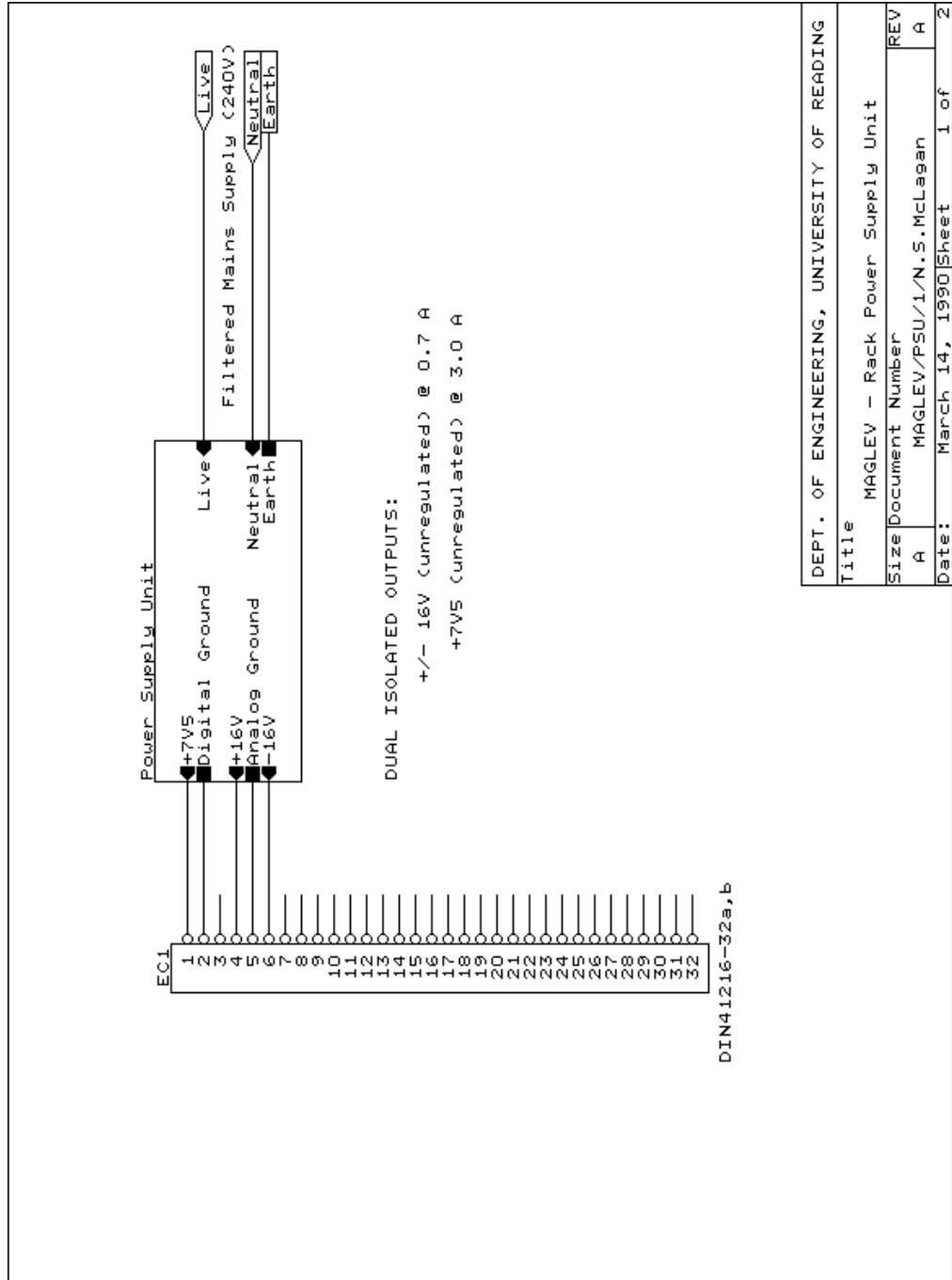
## D.6.3 EMCA card component parts list

ELECTROMAGNET CURRENT AMPLIFIER  
MAGLEV/EMCA/2/N.S.McLagan

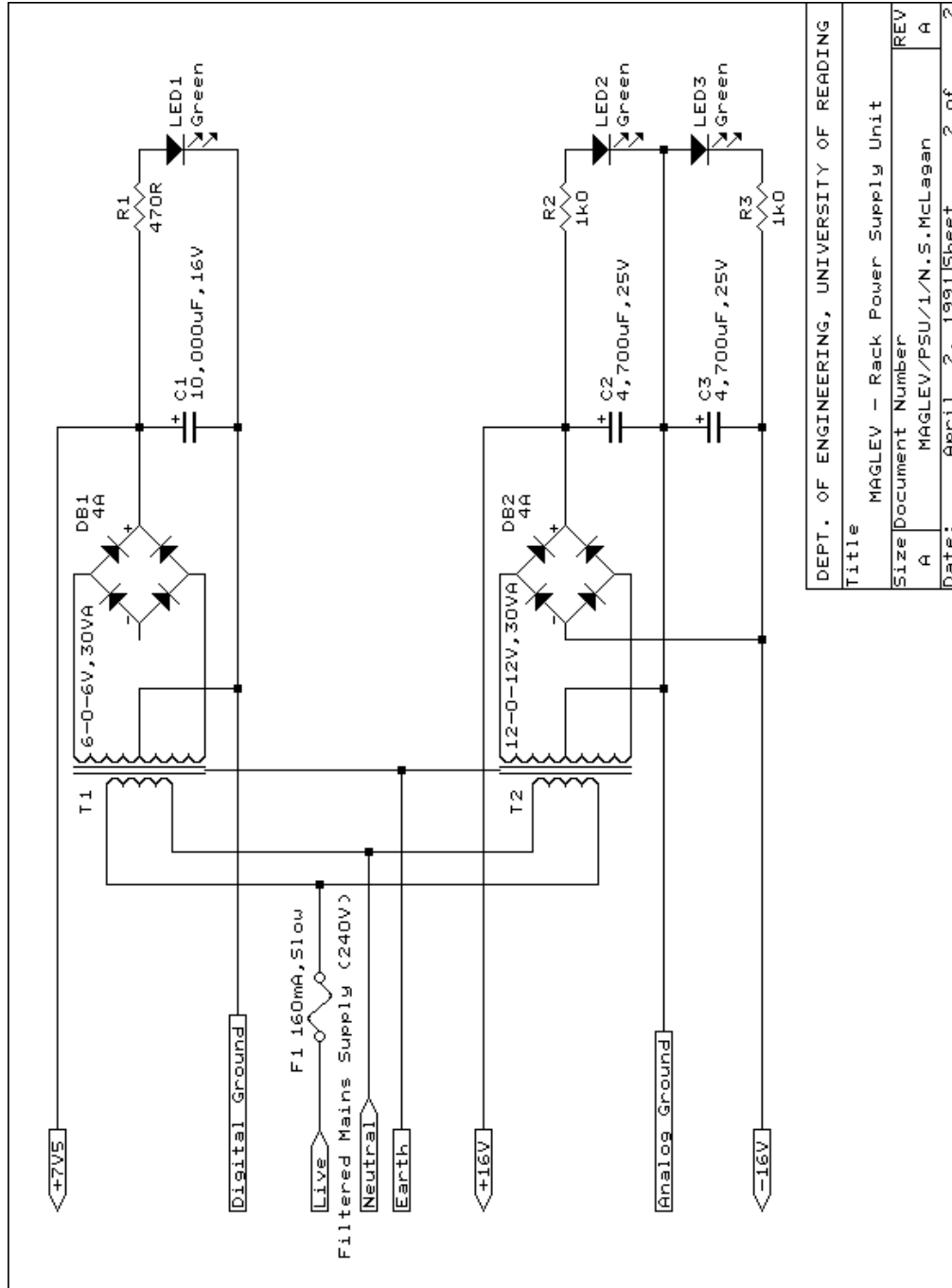
Revised: November 8, 1989  
Revision: A

<u>Quantity</u>	<u>Reference</u>	<u>Part</u>
1	C11	10nF
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13	C15, C3, C4, C5, C6, C7, C9, C13, C16, C18, C20, C21, C23	100nF
1	C24	6m8F, 63V
2	C25, C26	1uF, 63V
1	C8	22pF
3	D2, D1, D3	1N4148
1	D4	BAT85
2	D5, D6	UF4002
3	D7, D8, D9	MBR4060PT
1	EC1	DIN41216 'MH'
1	HECT	LT100-P/SP5
1	IC2	LM7912
1	IC3	TL084
1	IC5	LM3525
3	IC6, IC4, IC9	HCPL2531
2	IC7, IC10	LM7667
3	IC8, IC1, IC11	LM7812
10	J1A, J1B, J1C, J2A, J2B, J2C, J3A, J3B, J4A, J4B	20A Jumpers
2	L1, L2	100uH
1	L3	300nH
1	LED2	Green LED
2	LED3, LED1	Red LED
1	R1	51R, 1/2W
3	R10, R12, R14	100K
1	R11	2M7
1	R13	82K
6	R2, R6, R7, R8, R15, R16	10K
1	R20	470R, 1/4W
3	R21, R22, R24	100R
1	R25	4K7
1	R28	330R, 1/4W
2	R29, R34	2K7
6	R31, R17, R18, R19, R23, R36	15K
6	R33, R30, R32, R35, R37, R38	10R
1	R39	2K2, 1W
1	R4	1M0
3	R40, R3, R27	1K0
1	R41	1K8, 1/4W
1	R5	22K
2	R9, R26	47K
17	TP8, TP1, TP2, TP3, TP4, TP5, TP6, TP7, TP9, TP10, TP11, TP12, TP13, TP14, TP15, TP16, TP17	Test pins
1	TR1	BC108
2	TR2, TR3	MTH40N06
1	VR1	20K
1	VR2	5K
2	ZD1, ZD2	24V
1	ZD11	12V, 1W
1	ZD3	4V7
1	ZD4	2V7
2	ZD6, ZD9	56V, 3W
2	ZD7, ZD10	30V, 3W
2	ZD8, ZD5	16V, 1W

D.7 Chassis power supply module



D.7.1 PSU supply conditioning



## D.7.2 PSU card component parts list

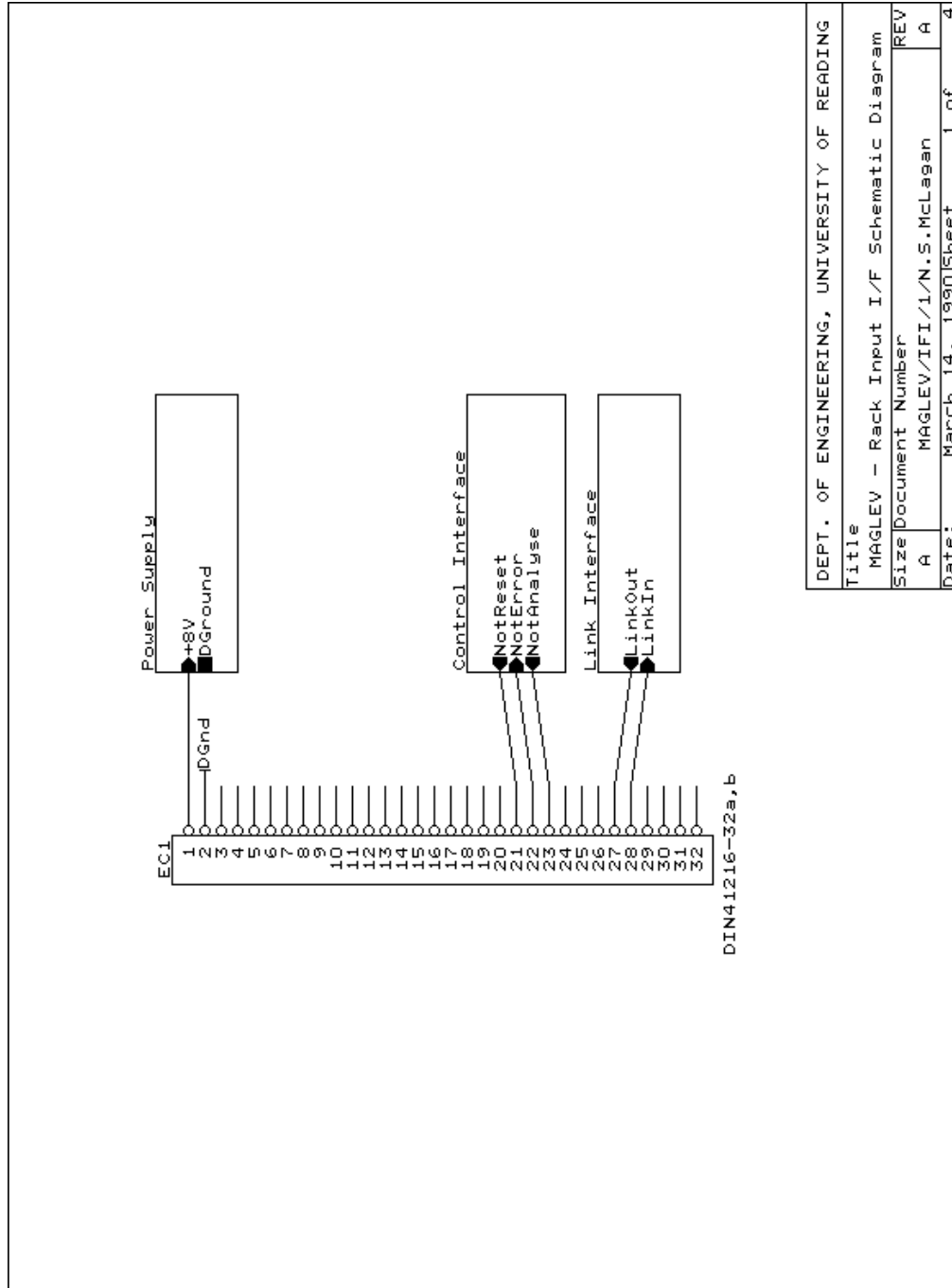
MAGLEV - Rack Power Supply Unit  
MAGLEV/PSU/1/N.S.McLagan

Revised: March 14, 1990  
Revision: A

Bill Of Materials April 2, 1991 17:45:25 Page 1

<u>Quantity</u>	<u>Reference</u>	<u>Part</u>
1	C1	10,000uF,16V
2	C2,C3	4,700uF,25V
2	DB1,DB2	4A
1	EC1	DIN41216-32a,b
1	F1	160mA, Slow
3	LED1,LED2,LED3	Green
1	R1	470R
2	R2,R3	1k0
1	T1	6-0-6V, 30VA
1	T2	12-0-12V, 30VA

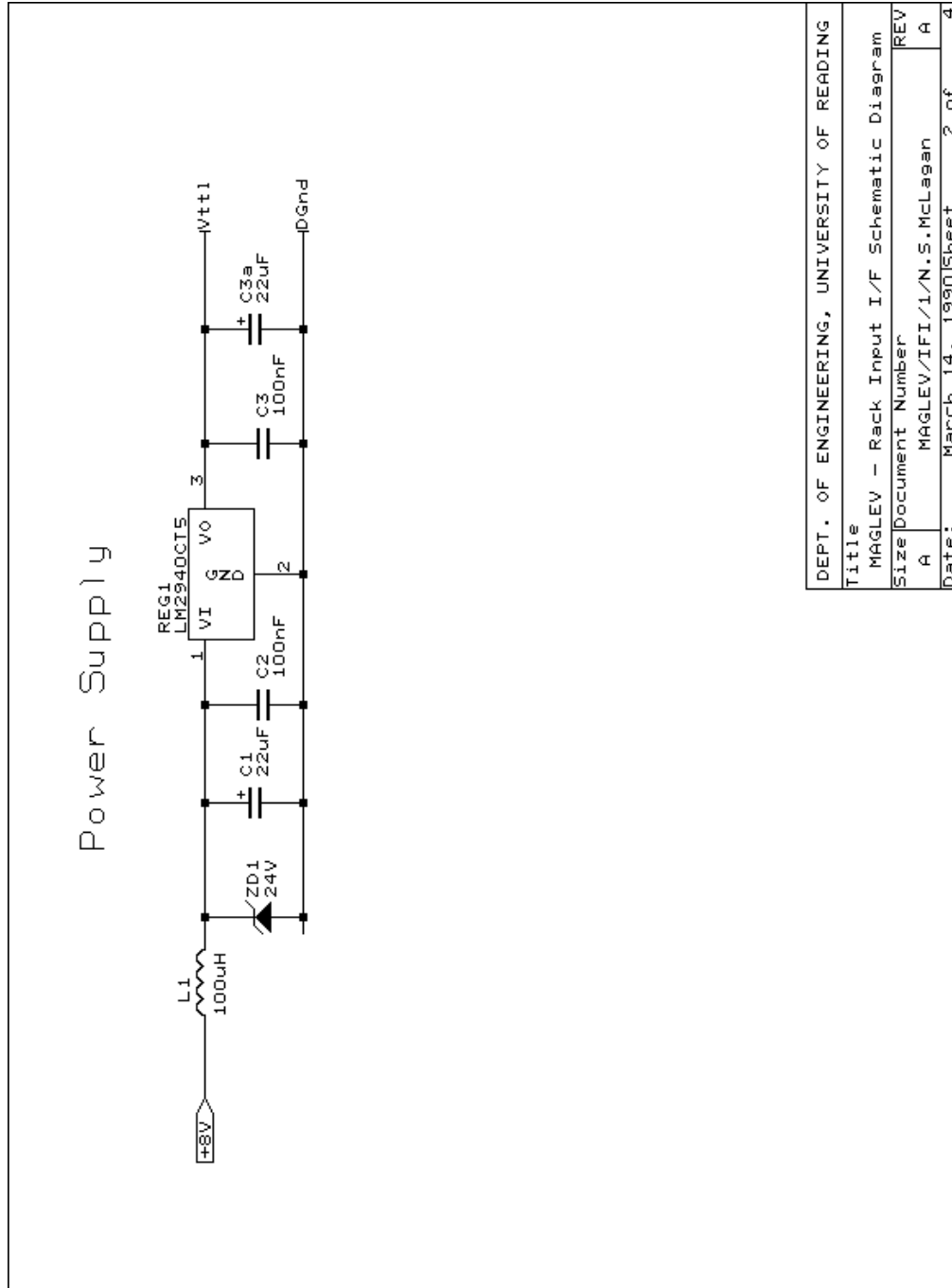
D.8 Chassis optical input interface card



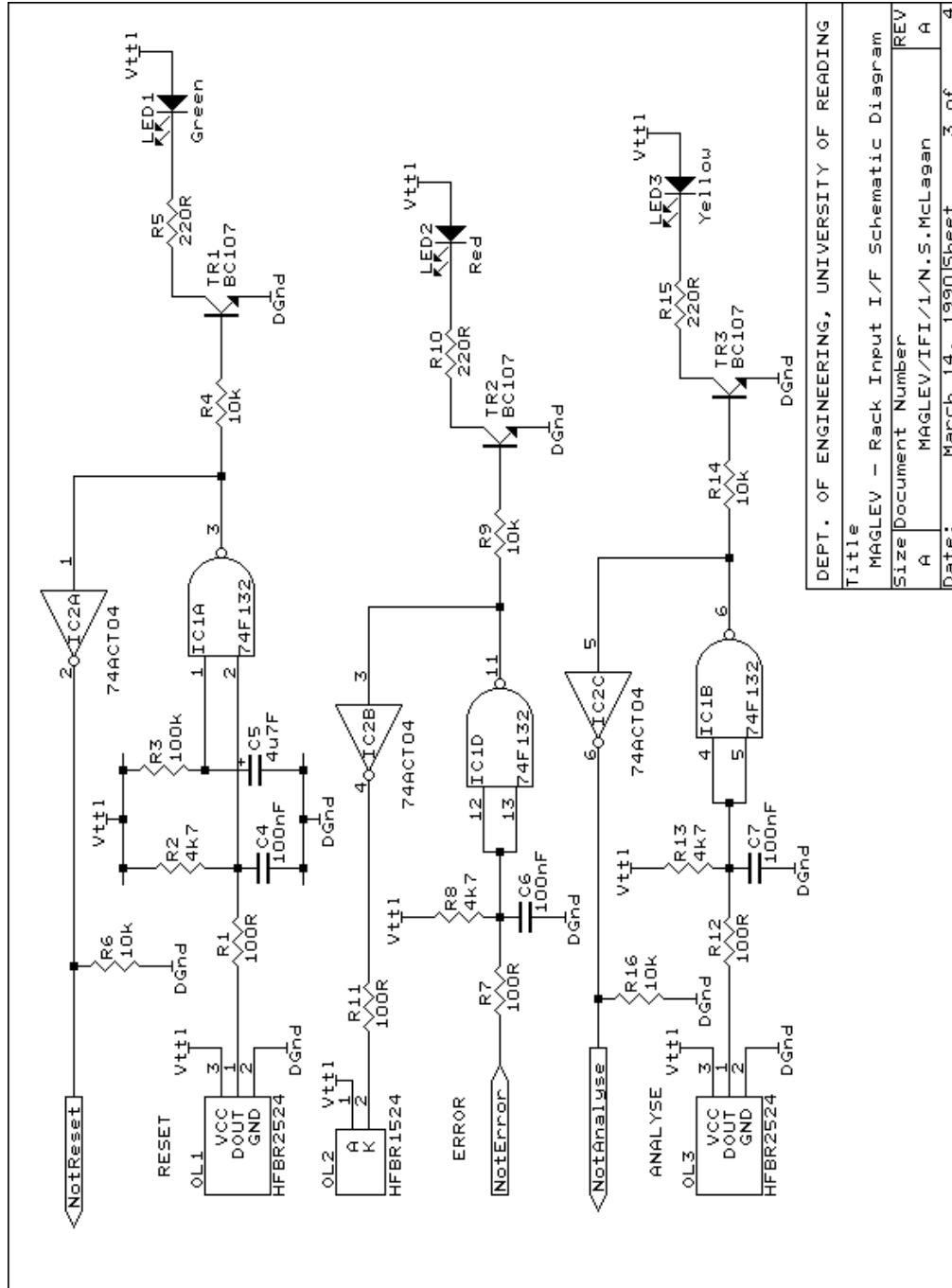
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Title	MAGLEV - Rack Input I/F Schematic Diagram
Size	Document Number
A	MAGLEV/IFI/1/N.S.McLagan
REV	A
Date:	March 14, 1990
Sheet	1 of 4



D.8.1 Chassis input interface power supply

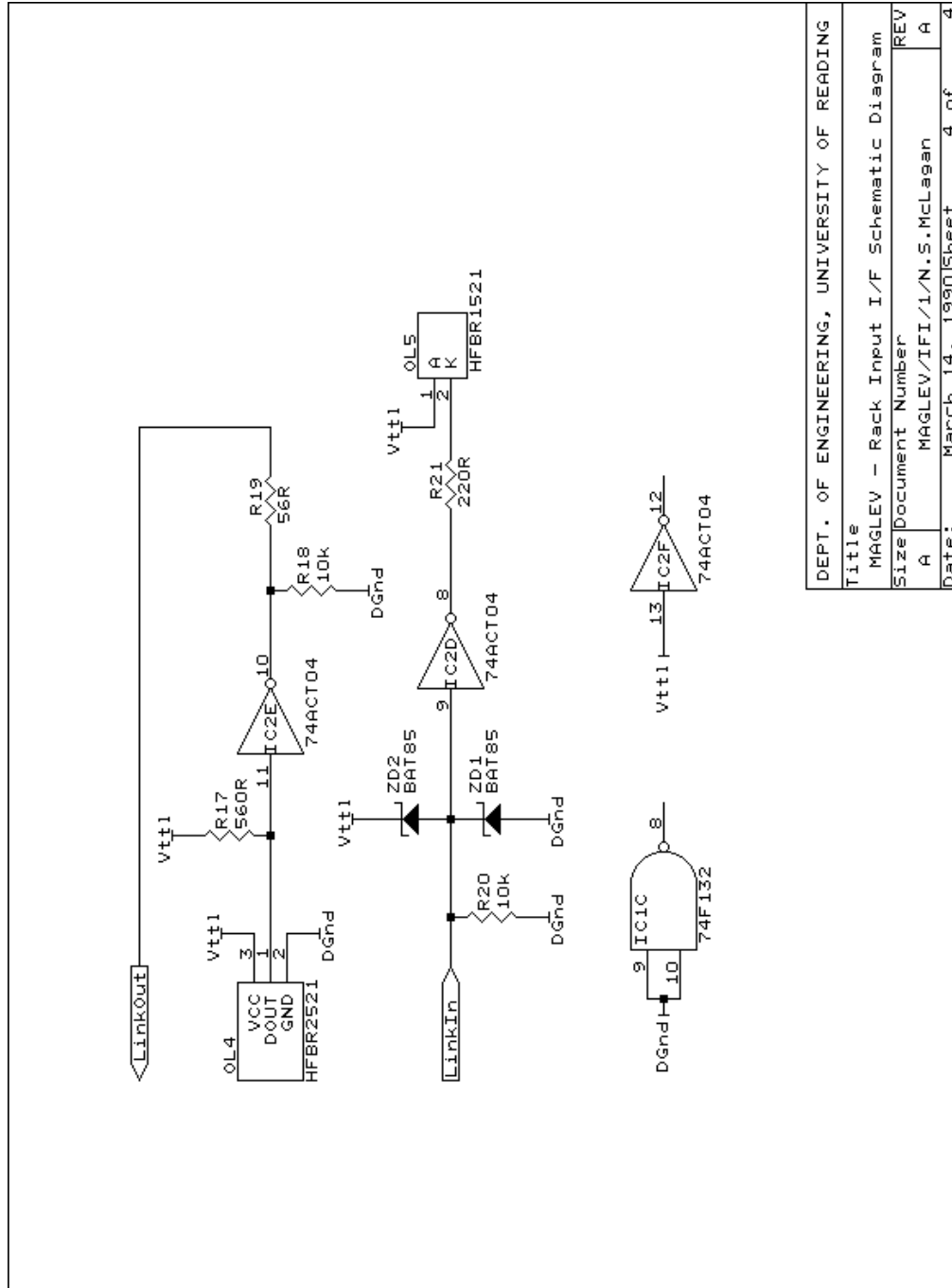


D.8.2 Chassis input interface control signals



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Title	MAGLEV - Rack Input I/F Schematic Diagram
Size	Document Number
REV	MAGLEV/IFI/1/N.S.McLagan
Date:	March 14, 1990
Sheet	3 of 4

D.8.3 Chassis input interface data signals



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Size	Document Number
REV	MAGLEV/IFI/1/N.S.McLagan
Date:	March 14, 1990
Sheet	4 of 4

## D.8.4 Chassis input interface card component parts list

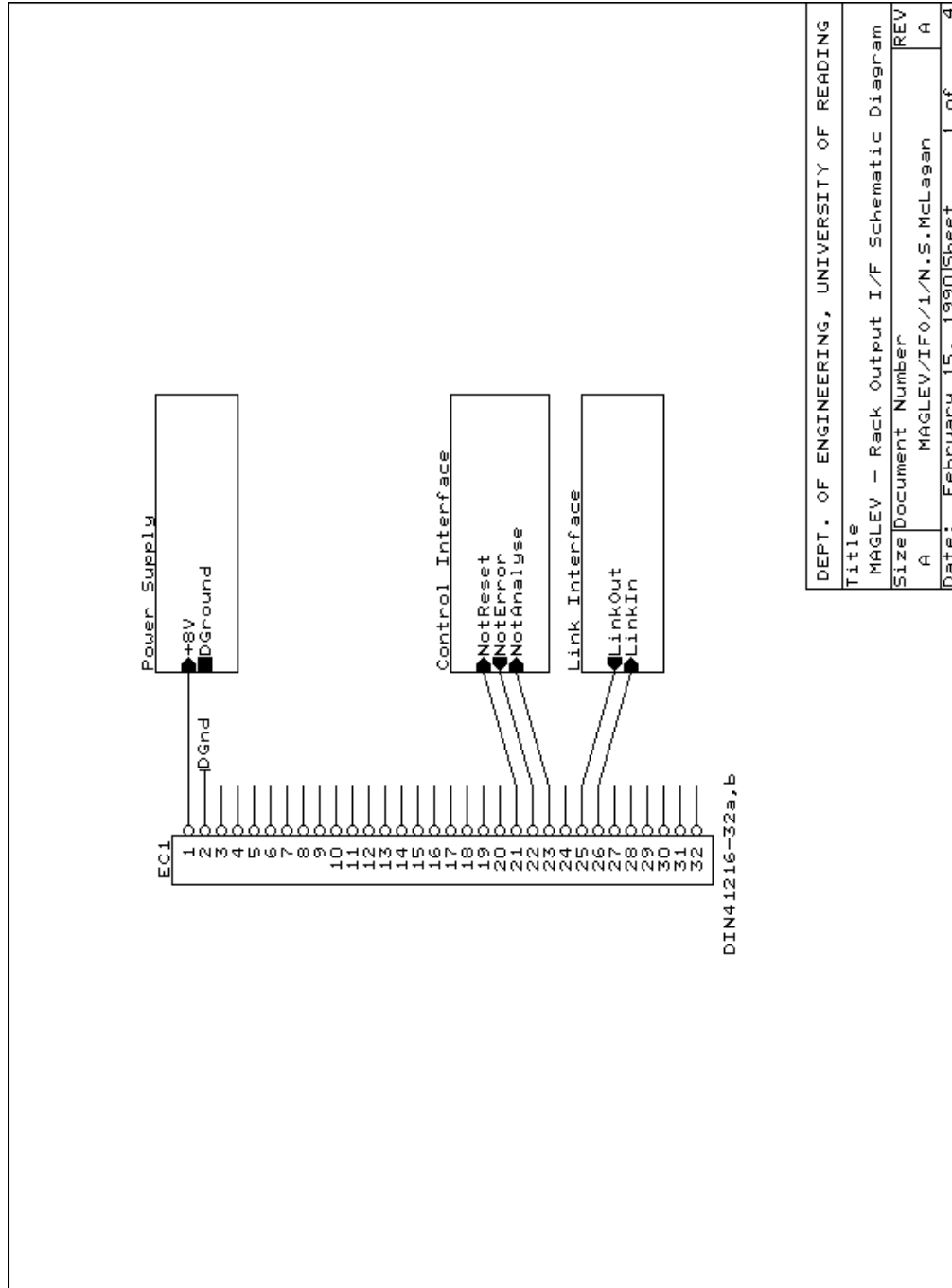
MAGLEV - Rack Input I/F Schematic Diagram  
 MAGLEV/IFI/1/N.S.McLagan

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 Revision: A

Bill Of Materials April 2, 1991 17:27:12 Page 1

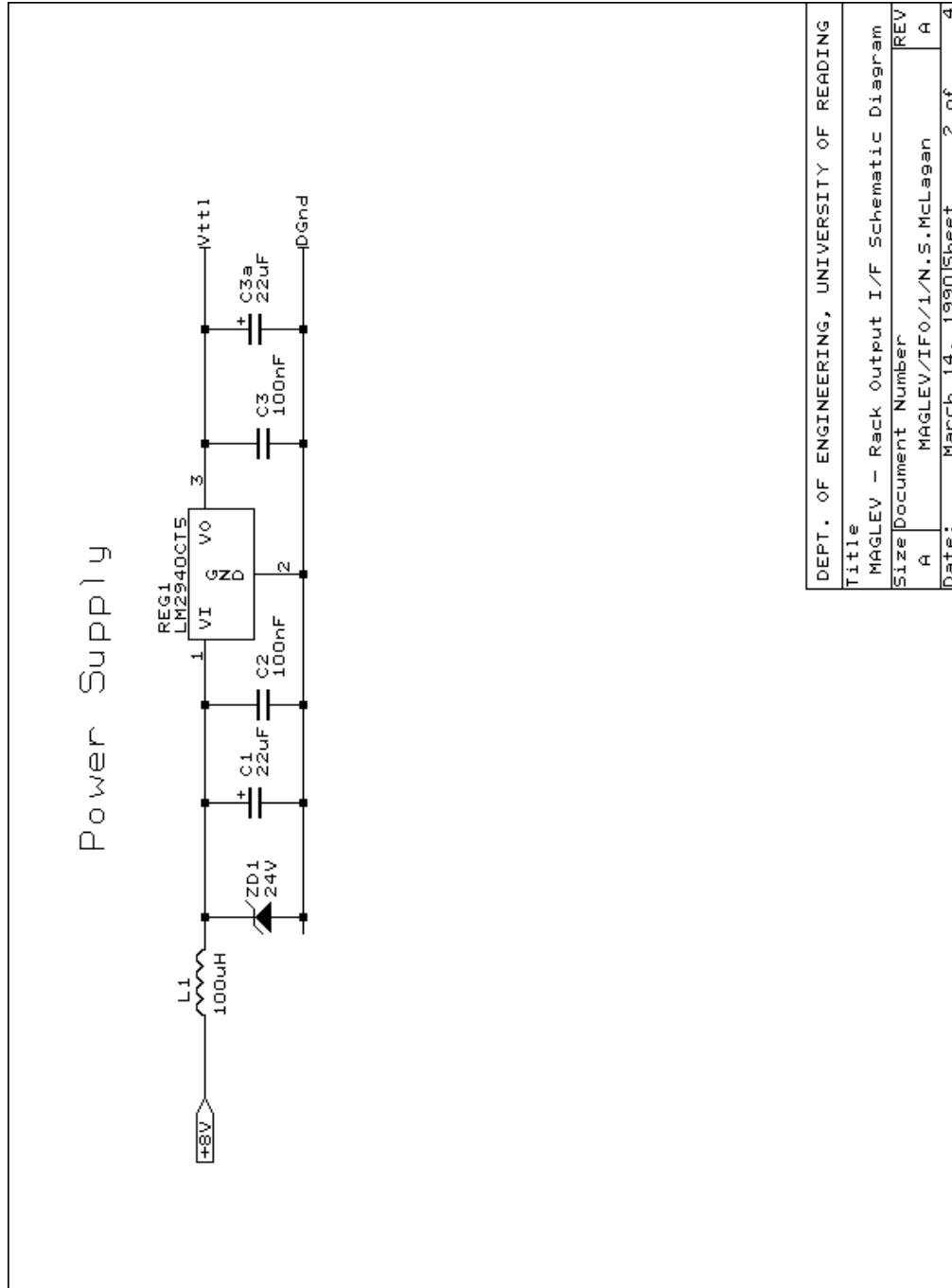
<u>Quantity</u>	<u>Reference</u>	<u>Part</u>
2	C1, C3a	22uF
5	C2, C3, C4, C6, C7	100nF
1	C5	4u7F
1	EC1	DIN41216-32a, b
1	IC1	74F132
1	IC2	74ACT04
1	L1	100uH
1	LED1	Green
1	LED2	Red
1	LED3	Yellow
2	OL1, OL3	HFBR2524
1	OL2	HFBR1524
1	OL4	HFBR2521
1	OL5	HFBR1521
3	R2, R8, R13	4k7
1	R3	100k
7	R4, R6, R9, R14, R16, R18, R20	10k
4	R1, R7, R11, R12	100R
4	R5, R10, R15, R21	220R
1	R17	560R
1	R19	56R
1	REG1	LM2940CT5
3	TR1, TR2, TR3	BC107
1	ZD1	24V
2	ZD1, ZD2	BAT85

D.9 Chassis optical output interface card

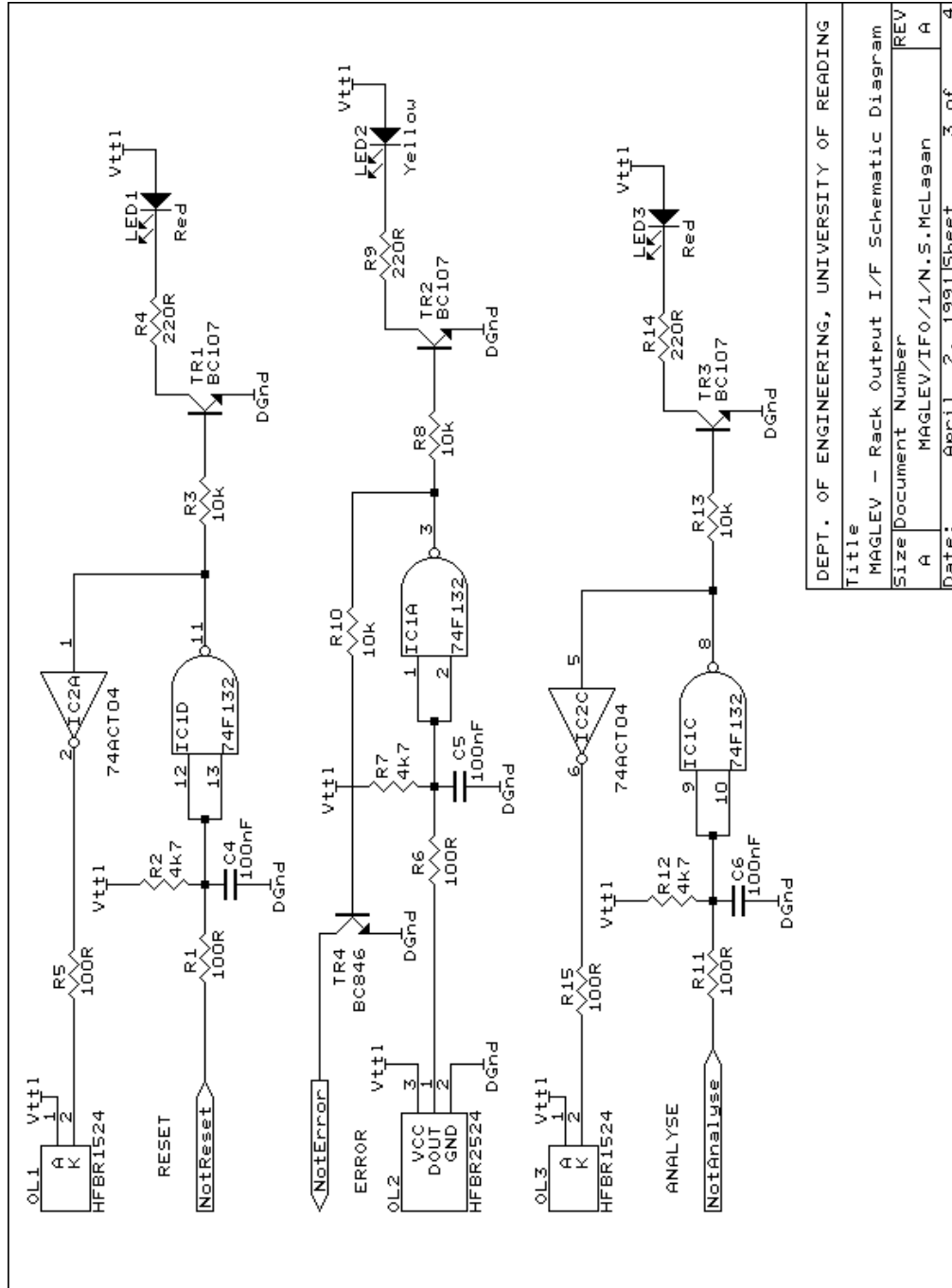


DEPT. OF ENGINEERING, UNIVERSITY OF READING	
Title	MAGLEV - Rack Output I/F Schematic Diagram
Size	Document Number
A	MAGLEV/IF0/1/N.S.McLagan
Date:	February 15, 1990
Sheet	1 of 4

D.9.1 Chassis output interface power supply

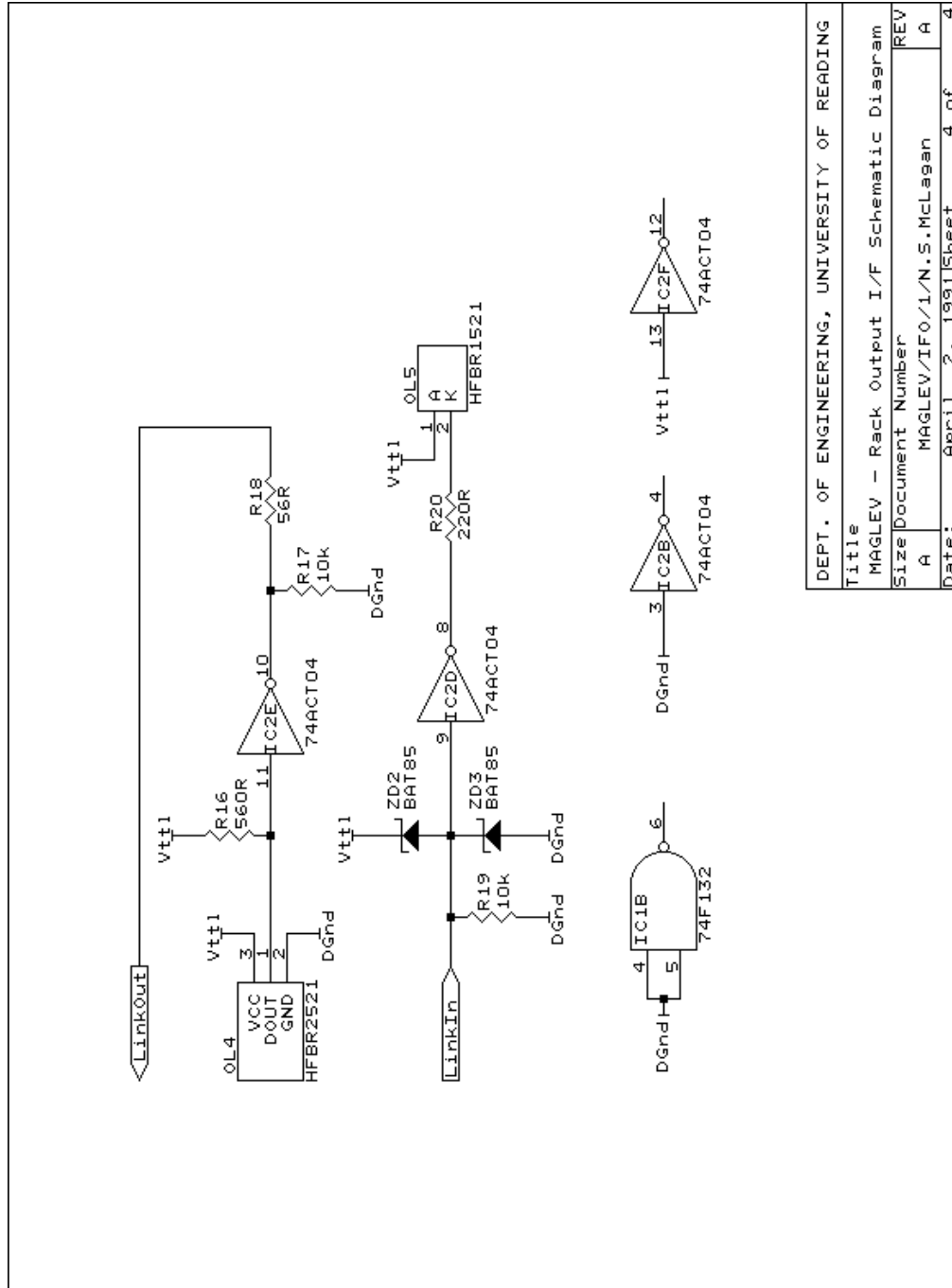


D.9.2 Chassis output interface control signals



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Title	MAGLEV - Rack Output I/F Schematic Diagram
Size	Document Number
REV	MAGLEV/IF0/1/N.S.McLagan
A	A
Date:	April 2, 1991 Sheet 3 of 4

D.9.3 Chassis output interface data signals



DEPT. OF ENGINEERING, UNIVERSITY OF READING	
Title	MAGLEV - Rack Output I/F Schematic Diagram
Size	Document Number
REV	MAGLEV/IF0/1/N.S.McLagan
Date:	April 2, 1991
Sheet	4 of 4



## D.9.4 Chassis output interface card component parts list

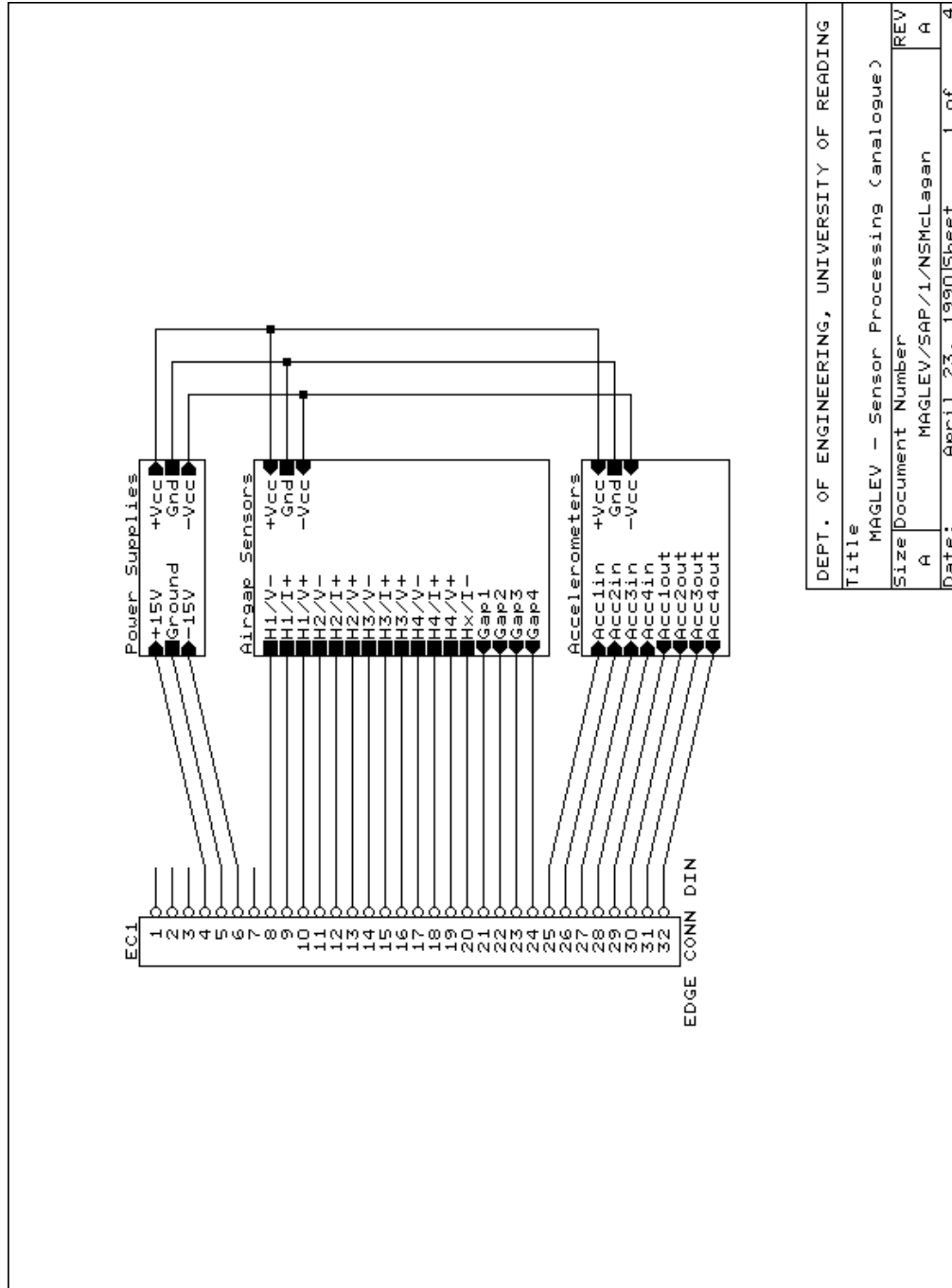
MAGLEV - Rack Output I/F Schematic Diagram  
MAGLEV/IFO/1/N.S.McLagan

Revised: February 15, 1990  
Revision: A

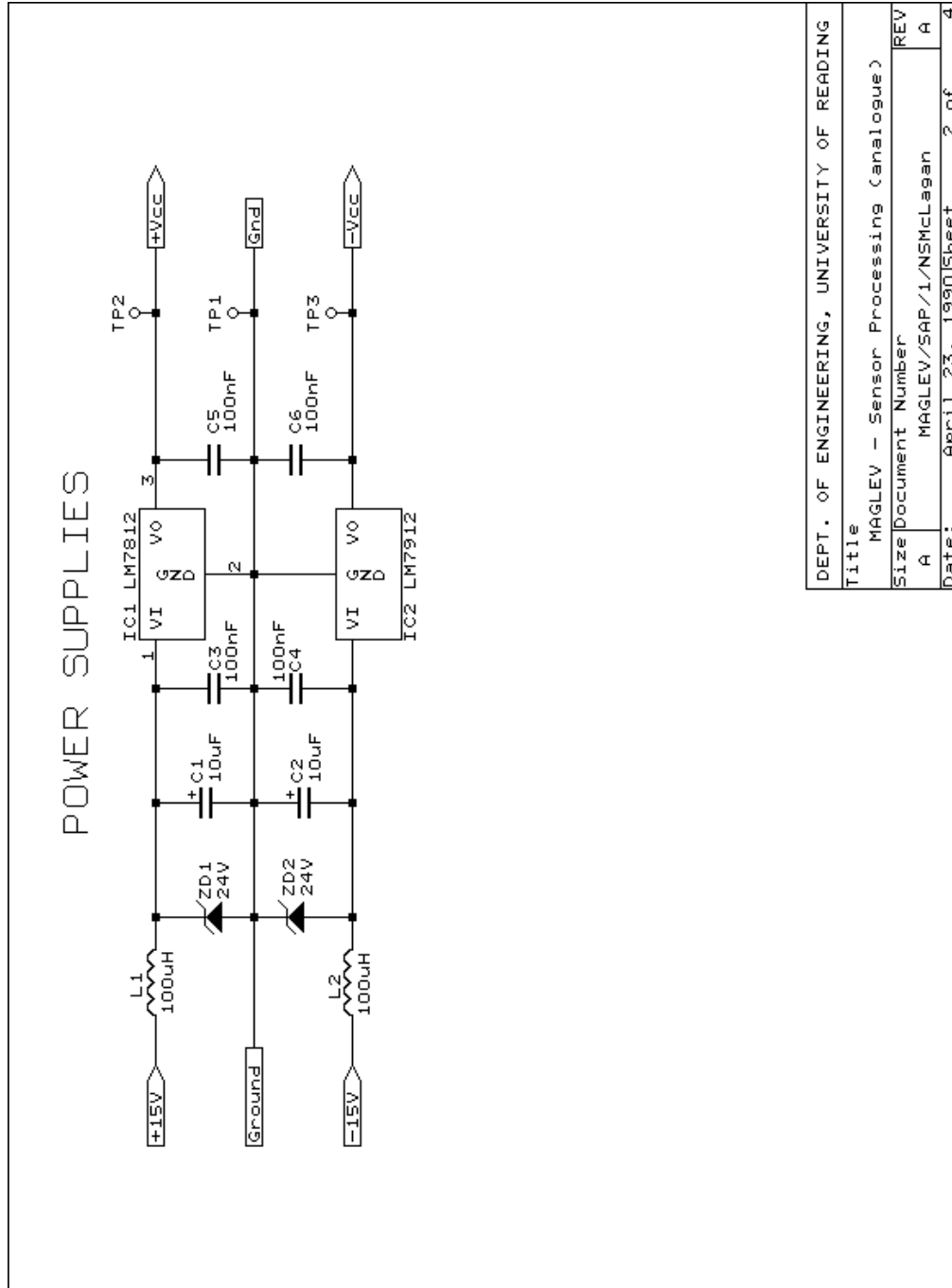
Bill Of Materials                      April 2, 1991                      17:45:09                      Page 1

<u>Quantity</u>	<u>Reference</u>	<u>Part</u>
2	C1, C3a	22uF
5	C2, C3, C4, C5, C6	100nF
1	EC1	DIN41216-32a, b
1	IC1	74F132
1	IC2	74ACT04
1	L1	100uH
2	LED1, LED3	Red
1	LED2	Yellow
2	OL1, OL3	HFBR1524
1	OL2	HFBR2524
1	OL4	HFBR2521
1	OL5	HFBR1521
3	R2, R7, R12	4k7
6	R3, R8, R10, R13, R17, R19	10k
5	R1, R5, R6, R11, R15	100R
4	R4, R9, R14, R20	220R
1	R16	560R
1	R18	56R
1	REG1	LM2940CT5
3	TR1, TR2, TR3	BC107
1	TR4	BC846
1	ZD1	24V
2	ZD2, ZD3	BAT85

D.10 Sensor analogue preprocessor (4 channel) card

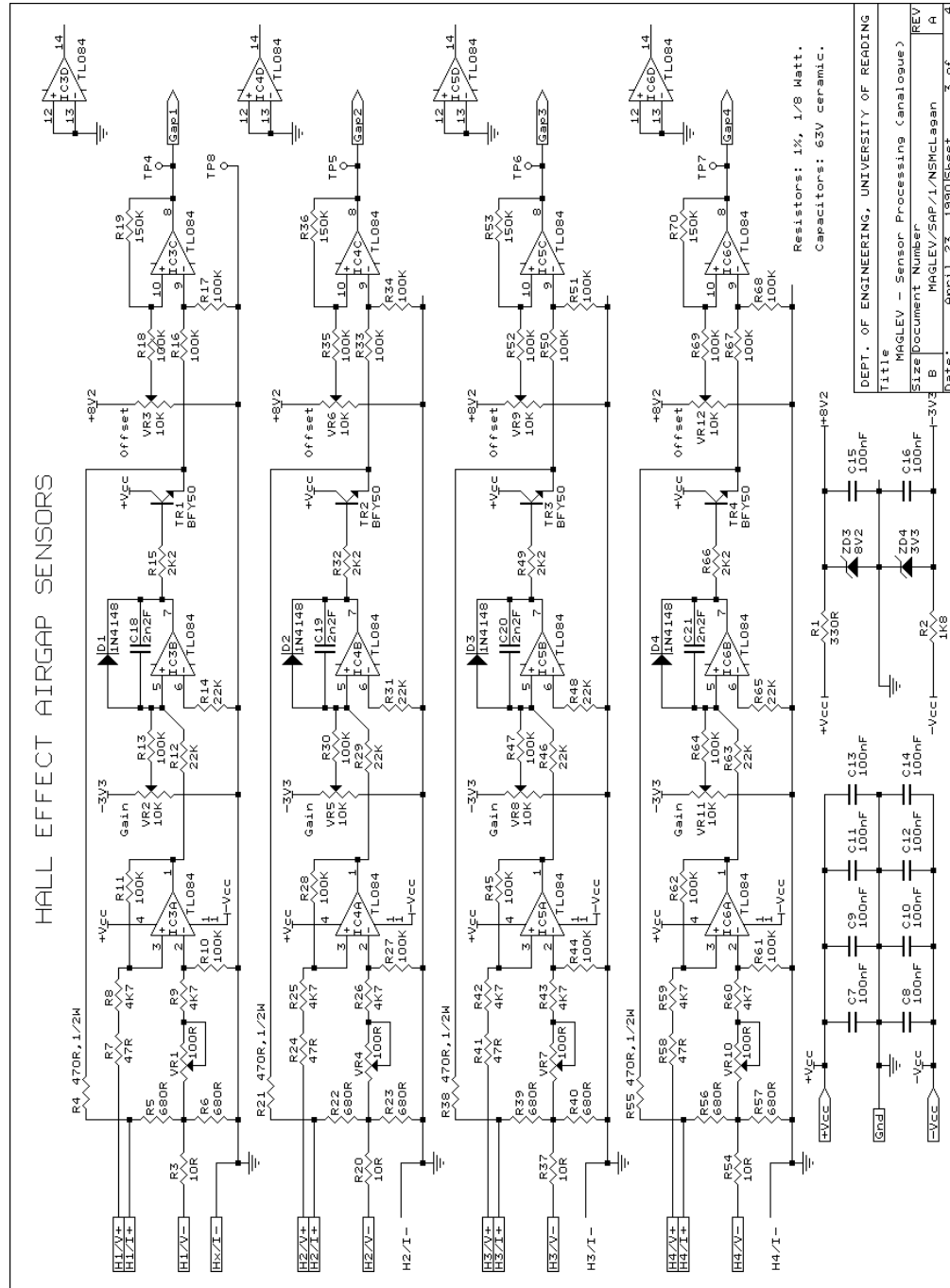


D.10.1 SAP card power supplies

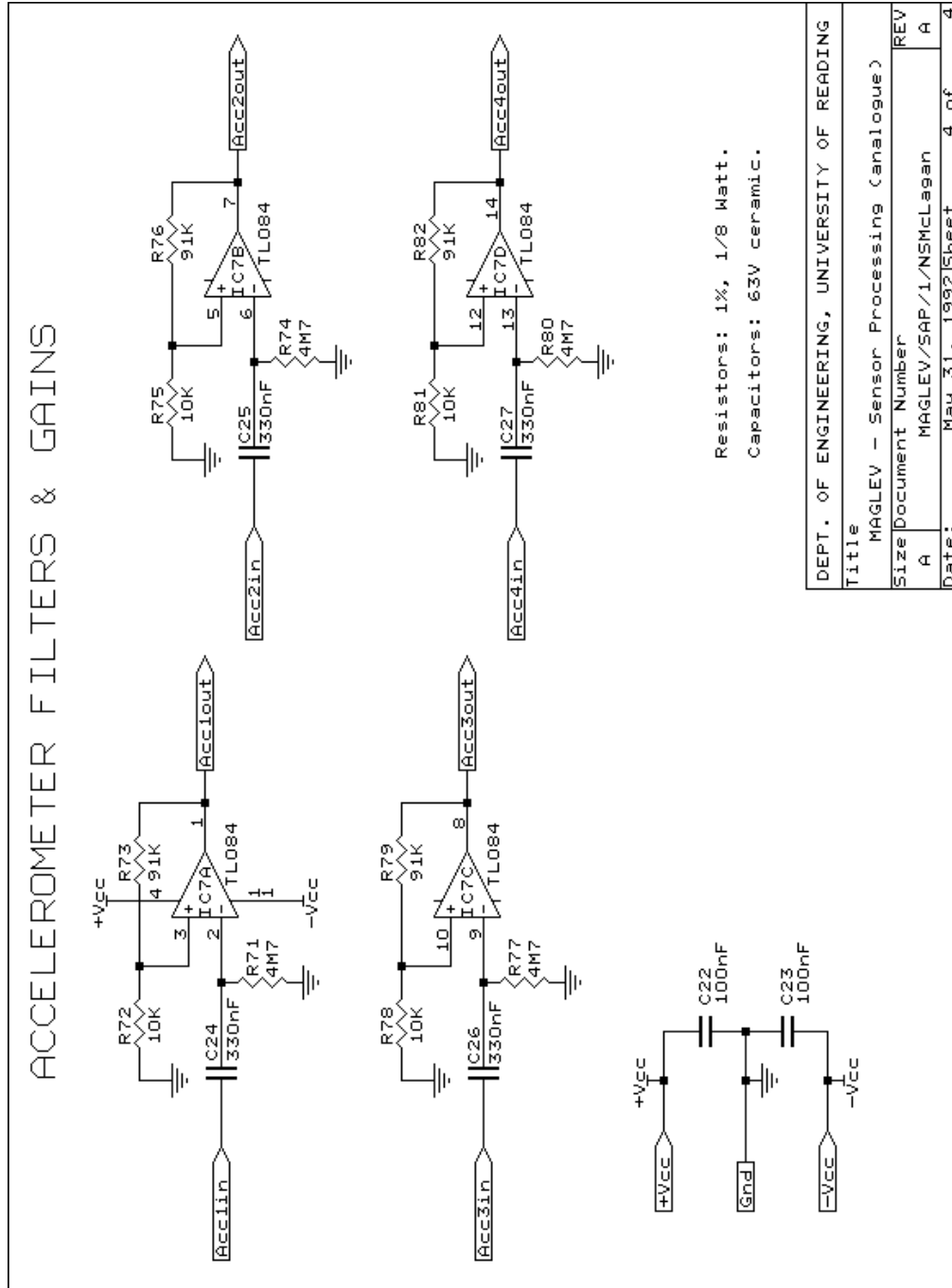


D.10.2 SAP Hall-effect air gap sensor controllers

Note: This circuitry is not implemented because commercial air gap sensors have been used instead. It is included here in case it is used in future systems.



D.10.3 SAP sensor filters and amplifiers



## D.10.4 SAP card component parts list

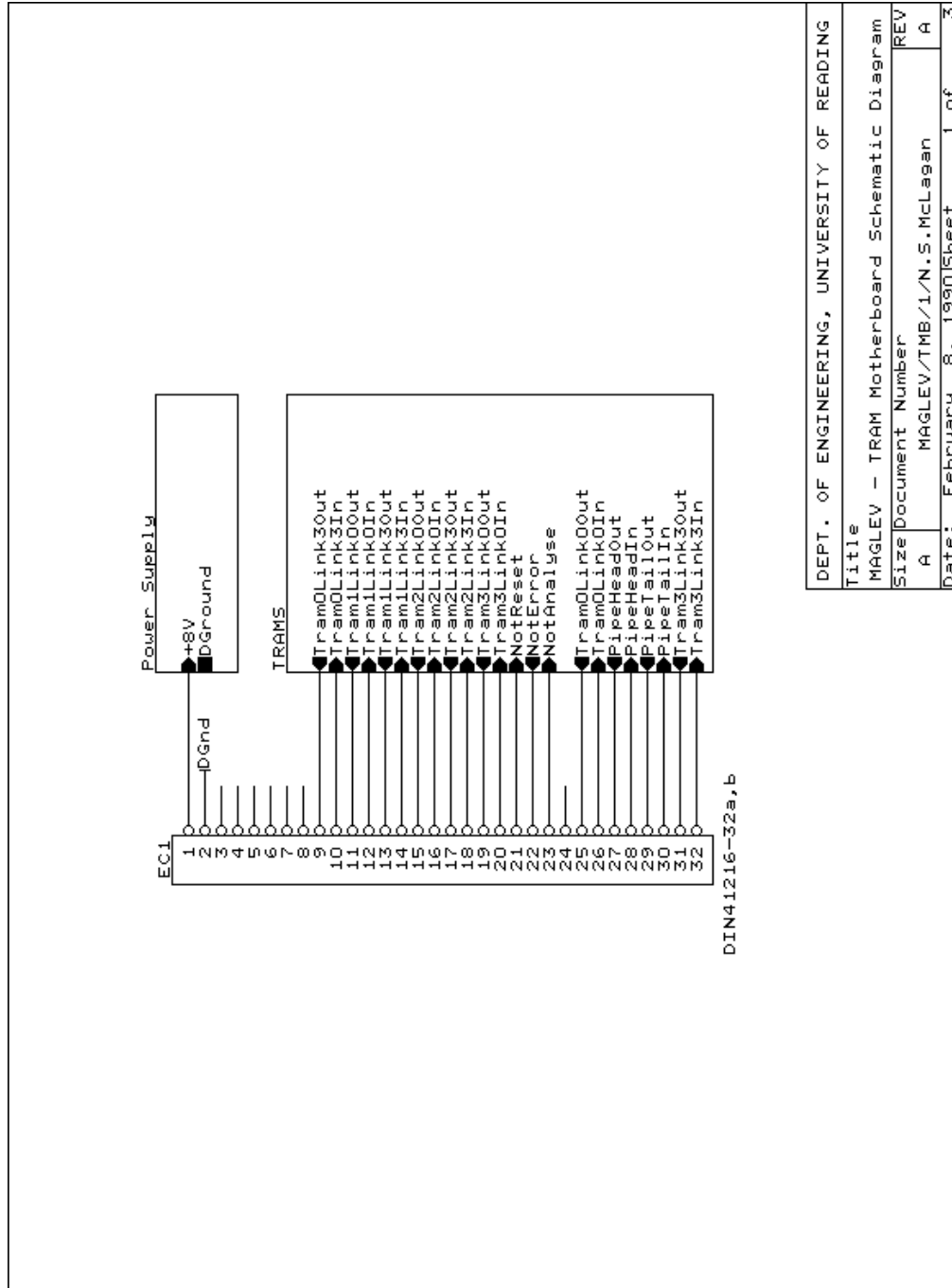
MAGLEV - Sensor Processing (analogue)  
MAGLEV/SAP/1/N.S.McLagan

Revised: November 2, 1989  
Revision: A

Bill Of Materials November 3, 1989 18:08:46 Page 1

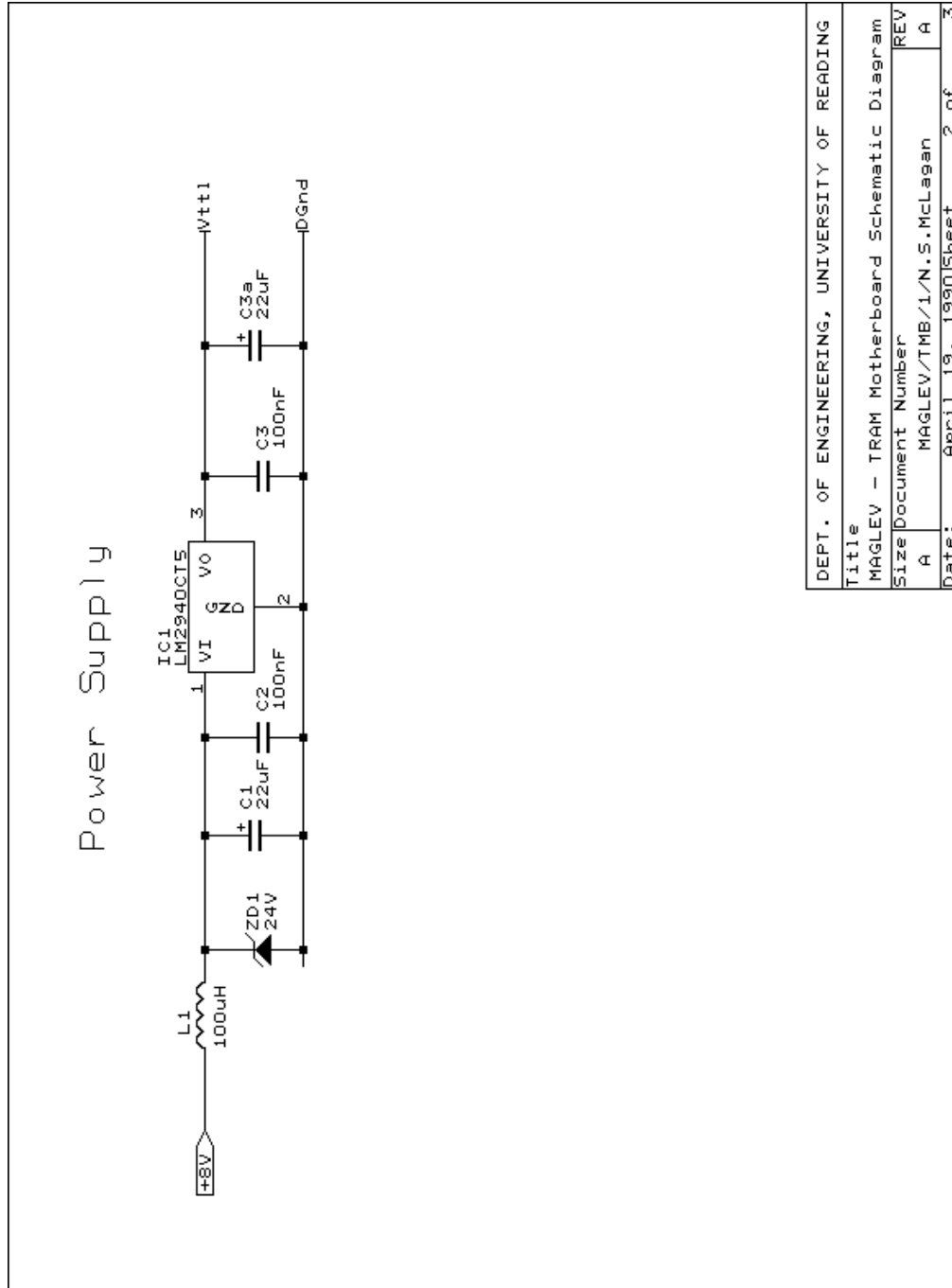
<u>Quantity</u>	<u>Reference</u>	<u>Part</u>
2	C1,C2	10uF
16	C15,C3,C4,C5,C6,C7,C8,C9, C10,C11,C12,C13,C14,C16, C22,C23	100nF
4	C18,C19,C20,C21	2n2F
4	C24,C25,C26,C27	330nF
4	D1,D2,D3,D4	1N4148
1	EC1	DIN41216-32a,c
1	IC1	LM7812
1	IC2	LM7912
5	IC3,IC4,IC5,IC6,IC7	TL084
2	L1,L2	100uH
1	R1	330R
24	R10,R11,R13,R16,R17,R18, R27,R28,R30,R33,R34,R35, R44,R45,R47,R50,R51,R52, R61,R62,R64,R67,R68,R69	100k
8	R12,R14,R29,R31,R46,R48, R63,R65	22k
4	R15,R32,R49,R66	2K2
4	R19,R36,R53,R70	150K
1	R2	1K8
4	R3,R20,R37,R54	10R
4	R4,R21,R38,R55	470R,1/2W
8	R6,R5,R22,R23,R39,R40, R56,R57	680R
4	R7,R24,R41,R58	47R
4	R71,R74,R77,R80	4M7
4	R72,R75,R78,R81	10K
4	R73,R76,R79,R82	91K
8	R9,R8,R25,R26,R42,R43, R59,R60	4k7
8	TP4,TP1,TP2,TP3,TP5,TP6, TP7,TP8	Test pins
4	TR1,TR2,TR3,TR4	BFY50
4	VR1,VR4,VR7,VR10	100R
9	VR3,VR2,VR5,VR6,VR8,VR9, VR11,VR12	10k
2	ZD1,ZD2	24V
1	ZD3	8V2
1	ZD4	3V3

D.11 Transputer motherboard (4 tram) card



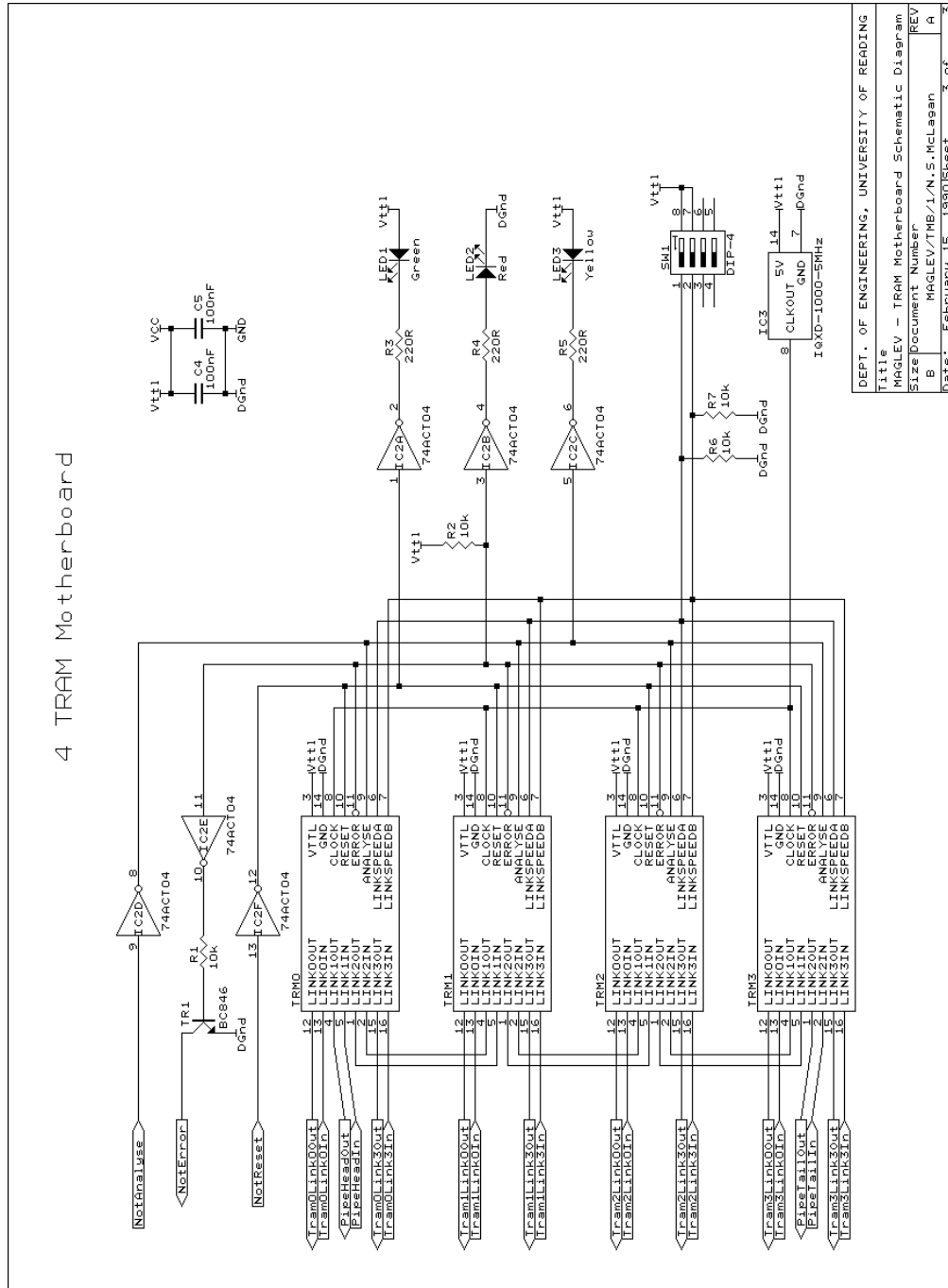
DEPT. OF ENGINEERING, UNIVERSITY OF READING	
Title MAGLEV - TRAM Motherboard Schematic Diagram	
Size	Document Number
A	MAGLEV/TMB/1/N.S.McLagan
Date: February 8, 1990	Sheet 1 of 3

D.11.1 TMB card power supply





D.11.2 TMB TRAM connectivity



DEPT. OF ENGINEERING, UNIVERSITY OF READING			
Title	MAGLEV - TRAM Motherboard Schematic Diagram	REV	
Size	Document Number		
B	MAGLEV/TMB/I.N.S.McLagan	A	
Date:	February 15, 1990	Sheet	3 of 3

## D.11.3 TMB card component parts list

MAGLEV - TRAM Motherboard Schematic Diagram Revised: February 7, 1990  
 MAGLEV/TMB/1/N.S.McLagan Revision: A

Bill Of Materials February 8, 1990 14:08:10 Page 1

<u>Quantity</u>	<u>Reference</u>	<u>Part</u>
1	C1	22uF
4	C2,C3,C4,C5	100nF
1	EC1	DIN41216-32a,b
1	IC1	LM2940CT5
1	IC2	74ACT04
1	IC3	IQXD-1000-5MHz Oscillator
1	L1	100uH
1	LED1	Green LED
1	LED2	Red LED
1	LED3	Yellow LED
4	R1,R2,R6,R7	10k
3	R3,R4,R5	220R
1	SW1	DIP 4-way SPST
1	TR1	BC107
1	ZD1	24V